

Maintenance and Service Guide

SUMMARY

This guide provides information about spare parts, removal and replacement of parts, security, backing up, and more.

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Product notice

This guide describes features that are common to most models. Some features may not be available on your computer.

Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. Go to http://www.microsoft.com for details.

To access the latest user guides, go to http://www.hp.com/support, and follow the instructions to find your product. Then select **Manuals**.

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For any further information or to request a full refund of the price of the computer, please contact your seller.

Safety warning notice

Reduce the possibility of heat-related injuries or of overheating the computer by following the practices described.

⚠ **WARNING!** To reduce the possibility of heat-related injuries or of overheating the computer, do not place the computer directly on your lap or obstruct the computer air vents. Use the computer only on a hard, flat surface. Do not allow another hard surface, such as an adjoining optional printer, or a soft surface, such as pillows or rugs or clothing, to block airflow. Also, do not allow the AC adapter to come into contact with the skin or a soft surface, such as pillows or rugs or clothing, during operation. The computer and the AC adapter comply with the user-accessible surface temperature limits defined by applicable safety standards.

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1 Product description

This table provides detailed product information.

Table 1-1 Product components and their descriptions

Category	Description	
Product Name	HP EliteBook x360 1030 G8 Notebook PC	
Processors	Intel® Core™ i7-1185G7 (3.00 GHz base frequency, up to 4.30 GHz with Intel Turbo Boost Technology, 12 MB cache, 4 cores)	
	Intel Core i7-1165G7 (2.80 GHz base frequency, up to 4.70 GHz with Intel Turbo Boost Technology, 12 MB cache, 4 cores)	
	Intel Core i5-1145G7 (2.60 GHz base frequency, up to 4.40 GHz with Intel® Turbo Boost Technology, 8 MB cache, 4 cores)	
	Intel Core i5-1135G7 (2.40 GHz base frequency, up to 4.20 GHz with Intel Turbo Boost Technology, 8 MB cache, 4 cores)	
Display	33.8 cm (13.3 in), WLED, UWVA, IPS, ultraslim, touch screen	
	Ultra high-definition (UHD) (3840 × 2160), BrightView, AMOLED, eDP 1.4 + PSR2; typical brightness: 400 nits	
	Full high-definition (FHD) (1920 × 1080), BrightView, 72%, eDP 1.4 + PSR2, Sure View Reflect; typical brightness: 1000 nits	
	FHD, BrightView, 72%, eDP + PSR, low power (LP); typical brightness: 400 nits	
	FHD, antiglare, 72%, eDP 1.4 + PSR2, LP; typical brightness: 400 nits	
	FHD, antiglare, 72%, eDP + PSR, Sure View Reflect; typical brightness: 1000 nits	
Memory	Nonupgradable integrated memory supporting up to 32 GB of RAM	
	LPDDR4-4266 dual-channel support	
	Supports the following configurations:	
	• 32 GB	
	• 16 GB	
	• 8 GB	
Primary storage	M.2 2280 solid-state drives, PCIe, NVMe	
	2 TB, PCIe-Gen3 × 4, TLC	
	1 TB, PCIe-Gen3 × 4, TLC	
	512 GB, PCIe-3 × 2 × 2 + 32 GB Optane™ memory module	
	512 GB, PCIe-Gen3 × 4, TLC, self-encrypted, OPAL2	
	512 GB, TLC	
	512 GB, value	
	256 GB, TLC	
	256 GB, PCIe-Gen3 × 4, TLC, self-encrypted, OPAL2	

Table 1-1 Product components and their descriptions (continued)

Category	Description		
	256 GB, value		
	128 GB, PCle-3 × 2, PCle, TLC		
	eMMC v5.0		
	32 GB		
Audio and video	Camera, HD + IR (infrared) 720p		
	Camera privacy cover		
	Dual-array digital microphone		
Near field communications (NFC) (select products only)	NXP NPC300 I2C		
Wireless	Wireless Local Area Network (WLAN)		
	Intel Wi-Fi 6 AX201 + Bluetooth® 5 (non-vPro®) (802.11ax 2 × 2, MU-MIMO, supporting gigabit file transfer speeds)		
	Intel Wi-Fi 6 AX201 + Bluetooth 5 (non-vPro) (802.11ax 2 × 2, MU-MIMO, supporting gigabit file transfer speeds)		
	Compatible with Miracast® devices		
	UEFI Wi-Fi		
	Supports HP Connection Optimizer (with data analytics) - Remote manageability for Connection Optimizer via MIK		
	Supports HP Extended Range Wireless LAN		
	Supports HP LAN-Wireless Protection (WLAN/LAN switching)		
	Supports Dynamic Antenna Gain (EU only)		
	Supports Indonesia New Band		
	Supports Time Average Power		
	Supports Time Average Power for WLAN		
	Supports Dynamic Antenna Gain		
	Wireless Wide Area Network (WWAN) (select products only)		
	Intel XMM™ 7360 LTE-Advanced (Cat 9)		
	- Antennas configured in display		
	- Compatible with programmable, removable eSIM		
	Qualcomm® Snapdragon® X55 LTE + 5G (Cat 20)		
	- Antennas configured in base		
	- Includes eSIM module		
Ports	HDMI 2.0		
	Audio-out (headphone)/audio-in (microphone) combo jack		

Table 1-1 Product components and their descriptions (continued)

Category	Description
	(2) USB Type-A ports
	(2) USB Type-C® ports
Sensors	Hall sensor
	Accelerometer + Gyroscope + eCompass
	Ambient light sensor
	IR thermal sensor
	HP Sure Platform
	Magnetometer
	Time of Flight
Keyboard/pointing	Keyboard
devices	Backlit, spill-resistant, premium keyboard for WWAN with clickpad
	Backlit, spill-resistant, privacy, premium keyboard for WWAN with clickpad
	Backlit, spill-resistant, premium keyboard with clickpad
	Backlit, spill-resistant, privacy, premium keyboard with clickpad
Power requirements	Battery (4 cell, 54 Whr, lipolymer)
	HP Long Life
	Fast charge
	AC adapters
	65 W AC adapter (non-PFC, slim, USB Type-C®, straight)
	65 W AC adapter (non-PFC, standard USB Type-C, straight, 1.8 m)
	Power cord
	C5, 1.0 m (3.3 ft) premium
	C5, 1.0 m (3.3 ft) conventional
Security	Trusted Platform Module (TPM) 2.0
	Fingerprint sensor (touch with SecureBIO sensor)
	Nano security lock
	Camera privacy key
Digital pen (select	WACOM AES 2.0 Pen with app launch button
products only)	WACOM AES 2.0 Pen with app launch button G3
Operating system	Windows® 10 Enterprise 64
	Windows 10 Enterprise 64 LTSC 1809 (RS5)
	Windows 10 Home 64
	Windows 10 Home 64 Advanced

Table 1-1 Product components and their descriptions (continued)

Category	Description	
	Windows 10 Home 64 Advanced Single Language	
	Windows 10 Home 64 High-End Chinese Market CPPP	
	Windows 10 Home 64 Plus	
	Windows 10 Home 64 Plus Single Language	
	Windows 10 Home 64 Plus Single Language Africa Market PPP	
	Windows 10 Home 64 Plus Single Language APAC EM PPP	
	Windows 10 Home 64 Plus Single Language India Market PPP	
	Windows 10 Home 64 Plus Single Language Indonesia Market PPP	
	Windows 10 Professional 64	
	Windows 10 Professional 64 CBB 1903	
	Windows 10 Professional 64 Chinese Market	
	Windows 10 Professional 64 StF MSNA Plus	
	FreeDOS	
Serviceability	End user replaceable part: AC adapter	

2 Components

Your computer features top-rated components. This chapter provides details about your components, where they are located, and how they work.

Right

Use the illustration and table to identify the components on the right side of the computer.

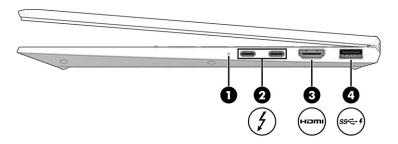


Table 2-1 Right-side components and their descriptions

Compone	nt	Description
(1)	Battery light	When AC power is connected:
		• White: The battery charge is greater than 90%.
		Amber: The battery charge is from 0 to 90%.
		Off: The battery is not charging.
		When AC power is disconnected (battery not charging):
		 Blinking amber: The battery has reached a low battery level. When the battery has reached a critical battery level, the battery light begins blinking rapidly.
		Off: The battery is not charging.
(2)	USB Type-C® power connectors and Thunderbolt™ ports with HP Sleep and Charge	Connects an AC adapter that has a USB Type-C connector, supplying power to the computer and, if needed, charging the computer battery.
		– and –
		Connects a USB device, provides high-speed data transfer, and charges small devices (such as a smartphone), even when the computer is off.
		NOTE: Use a standard USB Type-C charging cable or cable adapter (purchased separately) when charging a small external device.
		– and –
		Connects a display device that has a USB Type-C connector, providing DisplayPort™ output.
		NOTE: Your computer might also support a Thunderbolt docking station.

Table 2-1 Right-side components and their descriptions (continued)

Component			Description
(3)	нәті	HDMI port	Connects an optional video or audio device, such as a high- definition television, any compatible digital or audio component, or a high-speed High Definition Multimedia Interface (HDMI) device.
(4)	ss ← 4	USB SuperSpeed port with HP Sleep and Charge	Connects a USB device, provides high-speed data transfer, and charges small devices (such as a smartphone), even when the computer is off. NOTE: Use a standard USB Type-A charging cable or cable adapter (purchased separately) when charging a small external device.

Left

Use the illustration and table to identify the components on the left side of the computer.

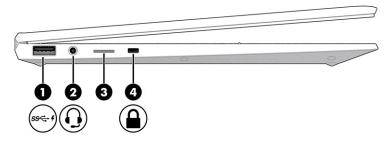


Table 2-2 Left-side components and their descriptions

Component Description		Description	
(1)	ss ⇔ ∮	USB SuperSpeed port with HP Sleep and Charge	Connects a USB device, provides high-speed data transfer, and charges small devices (such as a smartphone), even when the computer is off.
			NOTE: Use a standard USB Type-A charging cable or cable adapter (purchased separately) when charging a small external device.
(2)	O	Audio-out (headphone)/Audio-in (microphone) combo jack	Connects optional powered stereo speakers, headphones, earbuds, a headset, or a television audio cable. Also connects an optional headset microphone. This jack does not support optional standalone microphones.
			WARNING! To reduce the risk of personal injury, adjust the volume before putting on headphones, earbuds, or a headset. For additional safety information, see the <i>Regulatory, Safety, and Environmental Notices</i> .
			To access this guide:
			▲ Type HP Documentation in the taskbar search box, and then select HP Documentation.
			NOTE: When a device is connected to the jack, the computer speakers are disabled.

Table 2-2 Left-side components and their descriptions (continued)

Comp	onent		Description
(3)		Nano SIM card slot (select products only)	Supports a wireless subscriber identity module (SIM) card.
(4)		Nano security cable slot	Attaches an optional security cable to the computer. NOTE: The security cable is designed to act as a deterrent, but it might not prevent the computer from being mishandled or stolen.

Display

Use the illustration and table to identify the display components.



Table 2-3 Display components and their descriptions

Component		Description
(1)	WLAN antennas*	Send and receive wireless signals to communicate with wireless local area networks (WLANs).
(2)	Ambient light sensors (2)	Adjust the brightness of the display, depending on the ambient light.
(3)	Internal microphones (2)	Record sound.
(4)	Camera light(s)	On: One or more cameras are in use.
(5)	Camera	Allows you to video chat, record video, and record still images. Some cameras also allow a facial recognition logon to Windows, instead of a password logon.

Table 2-3 Display components and their descriptions (continued)

Component		Description	
		NOTE: Camera functions vary depending on the camera hardware and software installed on your product.	
(6)	User-proximity sensor	Uses facial recognition to monitor your presence in front of the computer to save power and add security. When you step away from the computer, the sensor puts the computer into the Sleep state. When you return to your computer, the sensor recognizes you and wakes the computer without a key press or mouse movement.	
(7)	WWAN antennas (select products only)*	Send and receive wireless signals to communicate with wireless wide area networks (WWANs).	

^{*}The antennas are not visible from the outside of the computer. For optimal transmission, keep the areas immediately around the antennas free from obstructions.

For wireless regulatory notices, see the section of the *Regulatory, Safety, and Environmental Notices* that applies to your country or region.

To access this guide:

▲ Type HP Documentation in the taskbar search box, and then select HP Documentation.

Keyboard area

Keyboards can vary by language.

Touchpad

The touchpad settings and components are described here.

Touchpad settings

You learn how to adjust the touchpad settings and components here.

Adjusting touchpad settings

Use these steps to adjust touchpad settings and gestures.

- 1. Type touchpad settings in the taskbar search box, and then press enter.
- Choose a setting.

Turning on the touchpad

Follow these steps to turn on the touchpad.

- 1. Type touchpad settings in the taskbar search box, and then press enter.
- 2. Using an external mouse, click the **Touchpad** button.

If you are not using an external mouse, press the Tab key repeatedly until the pointer rests on the **touchpad** button. Then press the spacebar to select the button.

Touchpad components

Use the illustration and table to identify the touchpad components.

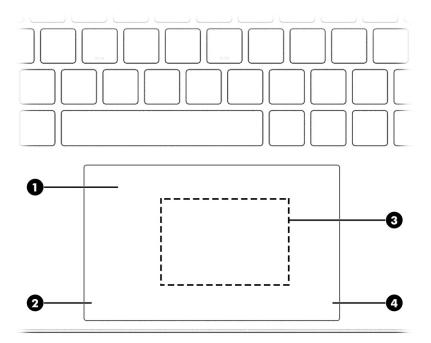


Table 2-4 Touchpad components and their descriptions

Component		Description
(1)	Touchpad zone	Reads your finger gestures to move the pointer or activate items on the screen.
(2)	Left touchpad button	Functions like the left button on an external mouse.
(3)	Near Field Communications (NFC) tapping area and antenna (select products only)	Allows you to wirelessly share information when you tap it with an NFC-enabled device.
(4)	Right touchpad button	Functions like the right button on an external mouse.

Lights

Use the illustration and table to identify the lights on the computer.

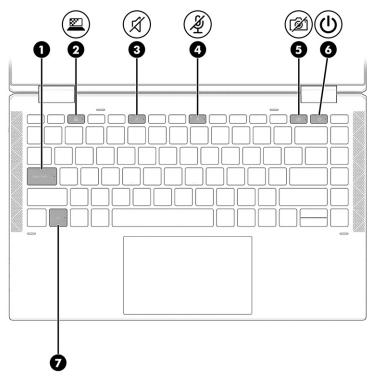


Table 2-5 Lights and their descriptions

Comp	Component		Description
(1)		Caps lock light	On: Caps lock is on, which switches the key input to all capital letters.
(2)	<u> </u>	Privacy key light (select products only)	On: Privacy screen is on, which helps prevent side-angle viewing.
(3)	Ø	Mute light	On: Computer sound is off.Off: Computer sound is on.
(4)	Ą	Microphone mute light	On: Microphone is off.Off: Microphone is on.
(5)	Ø	Camera privacy light	On: The camera is off.Off: The camera is on.
(6)	Ů	Power light	 On: The computer is on. Blinking (select products only): The computer is in the Sleep state, a power-saving state. The computer shuts off power to the display and other unnecessary components. Off: Depending on your computer model, the computer is off, in Hibernation, or in Sleep. Hibernation is the power-saving state that uses the least amount of power.
(7)		Fn lock light	On: The fn key is locked.

Button, speakers, and fingerprint reader

Fingerprint readers can be located on the touchpad, on a side panel of the computer, or on the top cover below the keyboard.

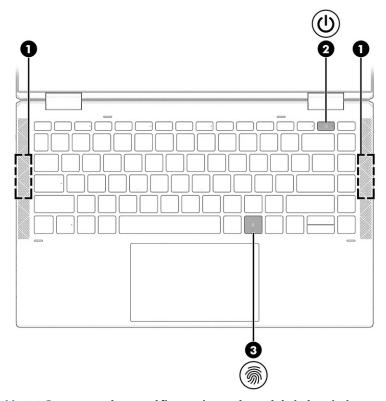


Table 2-6 Button, speakers, and fingerprint reader and their descriptions

Comp	onent	Description
(1)	Speakers (2)	Produce sound.
(2)	Power button	 When the computer is off, press the button briefly to turn on the computer.
		 When the computer is on, press the button briefly to initiate Sleep.
		 When the computer is in the Sleep state, press the button briefly to exit Sleep (select products only).
		 When the computer is in Hibernation, press the button briefly to exit Hibernation.
		IMPORTANT: Pressing and holding down the power button results in the loss of unsaved information.
		If the computer has stopped responding and shutdown procedures are ineffective, press and hold the power button for at least 4 seconds to turn off the computer.
		To learn more about your power settings, see your power options.

Table 2-6 Button, speakers, and fingerprint reader and their descriptions (continued)

Comp	onent		Description
			Right-click the Power meter icon and then select Power Options .
(3)	<u></u>	Fingerprint reader	Allows a fingerprint logon to Windows, instead of a password logon.
	-,.		Touch your finger to the fingerprint reader.
			IMPORTANT: To prevent fingerprint logon issues, make sure when you register your fingerprint that all sides of your finger are registered by the fingerprint reader.

Special keys

Use the illustration and table to identify the special keys.

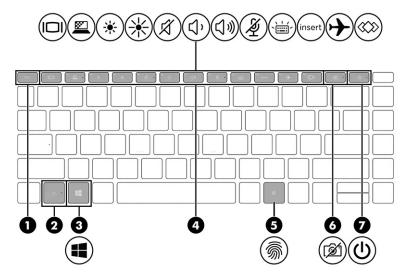


Table 2-7 Special keys and their descriptions

Comp	onent		Description
(1)		esc key	Displays system information when pressed in combination with the fn key.
(2)		fn key	Executes frequently used system functions when pressed in combination with another key. Such key combinations are called <i>hot keys</i> .
(3)	4	Windows key	Opens the Start menu. NOTE: Pressing the Windows key again will close the Start menu.
(4)		Action keys	Execute frequently used system functions.
(5)	<u></u>	Fingerprint reader	Allows a fingerprint logon to Windows, instead of a password logon. Touch your finger to the fingerprint reader.

Table 2-7 Special keys and their descriptions (continued)

Comp	onent		Description
			IMPORTANT: To prevent fingerprint logon issues, make sure when you register your fingerprint that all sides of your finger are registered by the fingerprint reader.
(6)	Ø	Camera privacy key	Turns the camera off and on.
(7)	(J)	Power button	When the computer is off, press the button briefly to turn on the computer.
			 When the computer is on, press the button briefly to initiate Sleep.
			 When the computer is in the Sleep state, press the button briefly to exit Sleep (select products only).
			 When the computer is in Hibernation, press the button briefly to exit Hibernation.
			IMPORTANT: Pressing and holding down the power button results in the loss of unsaved information.
			If the computer has stopped responding and shutdown procedures are ineffective, press and hold the power button for at least 4 seconds to turn off the computer.
			To learn more about your power settings, see your power options.
			Right-click the Power meter icon and then select
			Power Options.

Top cover

Use the illustration and table to identify the top cover component.

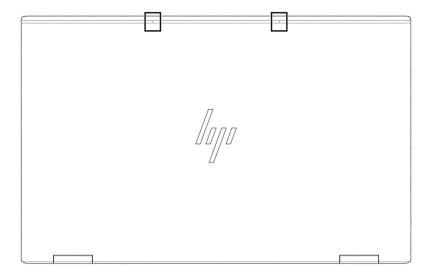


Table 2-8 Top cover component and its description

Component	Description
Internal microphones (2)	Record sound.

Bottom

Use the illustration and table to identify the bottom components.

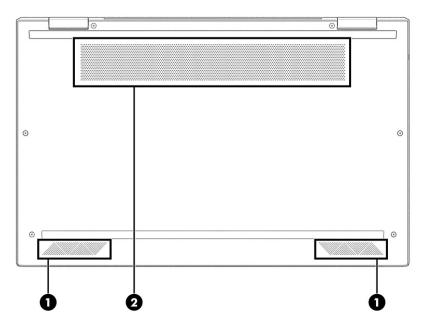


Table 2-9 Bottom components and their descriptions

Component		Description
(1)	Speakers (2)	Produce sound.
(2)	Vent	Enables airflow to cool internal components.
		NOTE: The computer fan starts up automatically to cool internal components and prevent overheating. It is normal for the internal fan to cycle on and off during routine operation.

Rear

Use the illustration and table to identify the rear component.



Table 2-10 Rear components and its description

Component	Description
Vent	Enables airflow to cool internal components.

Table 2-10 Rear components and its description

Component	Description
	NOTE: The computer fan starts up automatically to cool internal components and prevent overheating. It is normal for the internal fan to cycle on and off during routine operation.

Labels

The labels affixed to the computer provide information you might need when you troubleshoot system problems or travel internationally with the computer. Labels might be in paper form or imprinted on the product.

- **IMPORTANT:** Check the following locations for the labels described in this section: the bottom of the computer, inside the battery bay, under the service door, on the back of the display, or on the bottom of a tablet kickstand.
 - Service label—Provides important information to identify your computer. When contacting support, you
 might be asked for the serial number, the product number, or the model number. Locate this
 information before you contact support.

Your service label will resemble one of these examples. Refer to the illustration that most closely matches the service label on your computer.

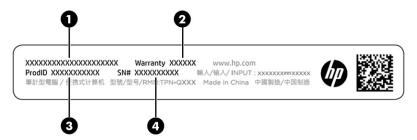


Table 2-11 Service label components

Comp	Component	
(1)	HP product name	
(2)	Warranty period	
(3)	Product ID	
(4)	Serial number	

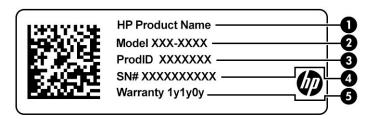


Table 2-12 Service label components

Comp	Component		
(1)	HP product name		
(2)	Model number		
(3)	Product ID		
(4)	Serial number		
(5)	Warranty period		

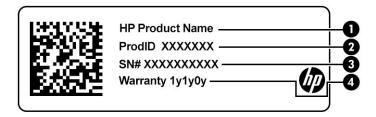


Table 2-13 Service label components

Comp	Component		
(1)	HP product name		
(2)	Product ID		
(3)	Serial number		
(4)	Warranty period		

- Regulatory labels—Provide regulatory information about the computer.
- Wireless certification labels—Provide information about optional wireless devices and the approval markings for the countries or regions in which the devices have been approved for use.

Using a SIM card (select products only)

Use these instructions to insert a SIM card.

IMPORTANT: You can damage the SIM card if you insert the wrong size card or insert it or the SIM card tray in the wrong direction. The card might also become stuck in the slot. Do not use SIM card adapters. To prevent damage to the SIM card or connectors, use minimal force when inserting or removing a SIM card.

Determining the correct SIM card size for your computer

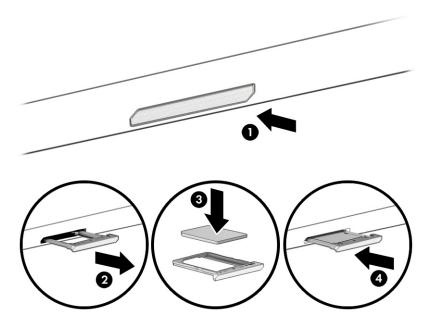
Before purchasing a SIM card, follow these instructions to determine the correct SIM card size for your computer.

- **1.** Go to http://www.hp.com/support, and then search for your computer by product name or number.
- 2. Select Product Information.
- **3.** Refer to the listed options to determine which card to purchase.

Inserting a nano SIM card

To insert a nano SIM card, follow these steps.

- 1. Position the computer display-side up on a flat surface.
- 2. Press in gently on the SIM card access tray to disengage the SIM lock, and the tray will pop out of the slot (1).
- 3. Remove the tray (2) from the computer and insert the card (3).
- 4. Replace the tray in the computer. Press in gently on the tray (4) until it is firmly seated.



To remove the SIM card, press in gently on the SIM card access tray to disengage the SIM lock, and the tray will pop out of the slot. Remove the SIM card. Replace the tray in the computer and press in gently on the tray until it is firmly seated.

Using Tile (select products only)

Some computers include a Tile™ Bluetooth® device that can help find your computer even when it is off or in the Sleep state. The Tile device operates in combination with the Tile software on your computer.

NOTE: The limit of the Tile Bluetooth signal is approximately 76 m (250 feet).

To use the Tile features on your computer:

- 1. Select the **Start** menu, and then select the **Tile** app.
- 2. Follow the on-screen instructions to create a Tile account and activate your Tile features.

3 Illustrated parts catalog

Use this table to determine the spare parts that are available for the computer.

Computer major components

To identify the computer major components, use this illustration and table.

NOTE: HP continually improves and changes product parts. For complete and current information about supported parts for your computer, go to http://partsurfer.hp.com, select your country or region, and then follow the on-screen instructions.

NOTE: Details about your computer, including model, serial number, product key, and length of warranty, are on the service tag on the bottom of your computer.

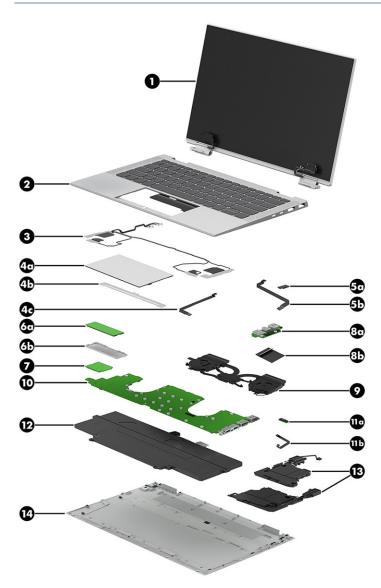


Table 3-1 Computer major component descriptions and part numbers

ltem	Component	Spare part number
(1)	Display assembly	
	UHD, AMOLED, 400 nits	M45812-001
	FHD, antiglare 400 nits	M45810-001
	FHD, BrightView, 400 nits	M45811-001
	FHD, antiglare, 1000 nits	M45813-001
	FHD, BrightView, 1000 nits	M45814-001
(2)	Top cover/keyboard	
	NOTE: For a detailed list of country codes, see the Top cover with keyboard topic.	
	Backlit, models without WWAN	M45819-xx1
	Backlit, privacy, models without WWAN	M45820-xx1
	Backlit, models with WWAN	M45821-xx1
	Backlit, privacy, models with WWAN	M45822-xx1
(3)	WWAN antenna (includes left and right antennas and cables)	
	Models without 5G	M20834-001
	Models with 5G	M27525-001
(4a)	Touchpad	
	For use only on computer models equipped with NFC capability	M45818-001
	For use only on computer models not equipped with NFC capability	M45817-001
(4b)	Touchpad bracket: The touchpad bracket is not available as a spare part.	
(4c)	Touchpad cable : The touchpad cable is available in the Cable Kit, spare part number M20833-001.	
(5a)	NFC module	M16045-001
(5b)	NFC module cable: The NFC module cable is available in the Cable Kit, spare part number M20833-00	01.
(6a)	Solid-state drive (M.2 2280, NVMe, PCIe)	
	512 GB + 32 GB Optane memory	L85366-001
	512 GB, self-encrypting (SED), TLC	L85368-001
	512 GB, value	L85364-001
	256 GB, TLC, value	L85354-001
	256 GB, self-encrypting (SED), TLC	M07245-001
	128 GB, TLC	M06792-001
(6b)	Solid-state drive bracket: The solid-state drive bracket is not available as a spare part.	
(7)	WWAN module	
	Intel XMM 7360 LTE-Advanced (Cat 9)	L70670-001
	Qualcomm Snapdragon X55 LTE + 5G	L83053-001

Table 3-1 Computer major component descriptions and part numbers (continued)

ltem	Component	Spare part number	
(8a)	Connector board	M16050-001	
	For use only on computer models equipped with WWAN capability	M16050-001	
	For use only on computer models not equipped with WWAN capability	M23394-001	
8b)	Connector board cable: The connector board cable is available in the Cable Kit, spare part number M20833-001.		
	Nano SIM tray (not illustrated, for use only on computer models equipped with WWAN capability)	M16053-001	
(9)	Fan/heat sink assembly (includes replacement thermal material)	M45823-001	
(10)	System board (includes integrated processor)		
	NOTE: All system board spare part kits include replacement thermal material.		
	All system boards use the following part numbers:		
	xxxxxx-001: Non-Windows operating systems		
	xxxxxx-601: Windows operating system		
	Intel Core i7-1185G7 processor with 32 GB of system memory (OSR)	M45838-xx1	
	Intel Core i7-1185G7 processor with 16 GB of system memory (OSR)	M45837-xx1	
	Intel Core i7-1185G7 processor with 16 GB of system memory	M45835-xx1	
	Intel Core i7-1185G7 processor with 8 GB of system memory (OSR)	M45836-xx1	
	Intel Core i7-1165G7 processor with 16 GB of system memory (OLED)	M45834-xx1	
	Intel Core i7-1165G7 processor with 16 GB of system memory	M45833-xx1	
	Intel Core i7-1165G7 processor with 8 GB of system memory	M45832-xx1	
	Intel Core i5-1145G7 processor with 16 GB of system memory (OSR)	M45831-xx1	
	Intel Core i5-1145G7 processor with 16 GB of system memory	M45829-xx1	
	Intel Core i5-1145G7 processor with 8 GB of system memory (OSR)	M45830-xx1	
	Intel Core i5-1145G7 processor with 8 GB of system memory	M45828-xx1	
	Intel Core i5-1135G7 processor with 16 GB of system memory (OLED)	M45827-xx1	
	Intel Core i5-1135G7 processor with 16 GB of system memory	M45826-xx1	
	Intel Core i3-1135G7 processor with 8 GB of system memory	M45825-xx1	
11a)	Sensor board:	M45824-001	
(11b)	Sensor board cable		
12)	Battery	L82391-006	
13)	Speakers (includes left and right speakers, cables, and rubber isolators)	M16052-001	
(14)	Bottom cover		
	For use only on computer models equipped with WWAN capability	M50566-001	
	For use only on computer models not equipped with WWAN capability	M50565-001	

Cables

To identify the cables, use this illustration and table.

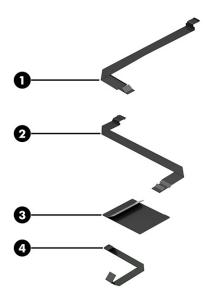


Table 3-2 Cable descriptions and part numbers

ltem	Component	Spare part number
	The following cables are available in the Cable Kit, spare part number M20833-001.	
(1)	Touchpad cable	
(2)	NFC module cable	
(3)	Connector board cable	
(4)	Sensor board cable	

Miscellaneous parts

To identify the miscellaneous parts, use this table.

Table 3-3 Miscellaneous part descriptions and part numbers

Component	Spare part number
AC adapter	
120 W, PFC, SMART, 7.4 mm	L57117-001
65 W, non-PFC, slim, USB Type-C, straight, 1.8 m (6.0 ft)	L04650-850
65 W, non-PFC, USB Type-C, RC, 1.8 m (6.0 ft)	L32392-001
65 W, non-PFC, USB Type-C, 1.8 m (6.0 ft)	L67440-001
65 W, non-PFC, USC-C, travel adapter	L21487-001
Adapters	

Table 3-3 Miscellaneous part descriptions and part numbers (continued)

Component	Spare part number
HP HDMI-to-VGA adapter	701943-001
HP USB Type-C-to-RJ45 adapter	855560-001
HP USB-C-to-USB 3.0 adapter	814618-001
Nano SIM tray	M16053-001
Solid-state drive support kit (includes shield and thermal pad)	M16055-001
Cable Kit (includes the connector board cable, NFC module cable, sensor board cable, and touchpad cable)	M20833-001
Miscellaneous Kit (includes WWAN gaskets, NFC module adhesive, WLAN protective shielding, WWAN protective shielding, and three thermal pads)	M16036-001
Hubs	
HP USB-C-to-USB-A Hub	916838-001
HP Elite USB-C Multi Port Hub	L39572-001
HP executive 14.1 slim top load case	L05333-001
Docks	
HP USB-C Dock with cable	L64086-001
HP USB Type-A/C universal dock with cable	L64087-001
HP USB Type-C mini dock	935327-001
Thunderbolt dock (120 W with cable)	L15809-001
Duckhead adapter	
C5NS, premium, sticker, black, for use in North America	L50818-002
C5NS, premium, sticker, black, for use in South Korea	L50818-001
Nano security lock	918431-001
HP Sure Key Cable Lock	L65088-001
Mouse	
HP Bluetooth travel mouse	L62043-001
HP comfort grip wireless mouse	691922-001
HP USB travel mouse	757770-001
HP AES 2.0 pen with app button	L57041-001
Power cord, C5, premium, generic, 1.0 m [3.3 ft])	
Argentina	920689-003
India	920689-016
North America	920689-001
People's Republic of China	920689-014

Table 3-3 Miscellaneous part descriptions and part numbers (continued)

Component	Spare part number
For use in Argentina	L19357-001
For use in Australia	L19358-001
For use in Brazil	L19359-001
For use in Denmark	L19360-001
For use in Europe	L19361-001
For use in India	L19363-001
For use in Israel	L19362-001
For use in Italy	L19364-001
For use in Japan	L19365-001
For use in North America	L19367-001
For use in The People's Republic of China	L19368-001
For use in South Africa	L19369-001
For use in South Korea	L19366-001
For use in Switzerland	L19370-001
For use in The United Kingdom	L19373-001
Power cord (C5, conventional, 1.8 m [6.0 ft])	
For use in Argentina	L19357-002
For use in Australia	L19358-002
For use in Brazil	L19359-002
For use in Denmark	L19360-002
For use in Europe	L19361-002
For use in India	L19363-002
For use in Israel	L19362-002
For use in Italy	L19364-002
For use in Japan	L19365-002
For use in North America	L19367-002
For use in The People's Republic of China	L19368-002
For use in South Africa	L19369-002
For use in South Korea	L19366-002
For use in Switzerland	L19370-002
For use in The United Kingdom	L19373-002
Power cord (C5, premium, 1.0 m [3.3 ft])	
For use in Argentina	L30811-001

Table 3-3 Miscellaneous part descriptions and part numbers (continued)

Component	Spare part number
For use in Australia	L22327-001
For use in Brazil	L30812-001
For use in Denmark	L22322-001
For use in Europe	L22321-001
For use in India	L22624-001
For use in Israel	L22323-001
For use in Italy	L30813-001
For use in Japan	L22330-001
For use in North America	L22319-001
For use in The People's Republic of China	L21930-001
For use in South Africa	L22325-001
For use in South Korea	L22328-001
For use in Switzerland	L22324-001
For use in Taiwan	L22329-001
For use in Thailand	L22326-001
For use in The United Kingdom	L22320-001
Power cord (C5, duckhead, premium, 1.0 m [3.3 ft])	
For use in Argentina	L36815-001
For use in Australia	L36816-001
For use in Brazil	L44789-001
For use in Denmark	L36817-001
For use in Europe	L36818-001
For use in India	L36820-001
For use in Israel	L36819-001
For use in Italy	L44788-001
For use in North America	L36822-001
For use in The People's Republic of China	L36823-001
For use in South Africa	L36824-001
For use in Switzerland	L36825-001
For use in Taiwan	L36827-001
For use in Thailand	L36826-001
For use in The United Kingdom	L36828-001

Table 3-3 Miscellaneous part descriptions and part numbers (continued)

Component	Spare part number
Power cord (duckhead, for use in Japan)	L33157-001
Screw Kit	M16054-001

Removal and replacement procedures preliminary requirements

Use this information to properly prepare to disassemble and reassemble the computer.

Service considerations

The following sections include some of the considerations that you must keep in mind during disassembly and assembly procedures.



NOTE: As you remove each subassembly from the computer, place the subassembly (and all accompanying screws) away from the work area to prevent damage.

Plastic parts

Using excessive force during disassembly and reassembly can damage plastic parts.

Cables and connectors

Handle cables with extreme care to avoid damage.

IMPORTANT: When servicing the computer, be sure that cables are placed in their proper locations during the reassembly process. Improper cable placement can damage the computer.

Apply only the tension required to unseat or seat the cables during removal and insertion. Handle cables by the connector whenever possible. In all cases, avoid bending, twisting, or tearing cables. Be sure that cables are routed so that they cannot be caught or snagged as you remove or replace parts. Handle flex cables with extreme care; these cables tear easily.

Drive handling

Note the following guidelines when handling drives.

IMPORTANT: Drives are fragile components. Handle them with care. To prevent damage to the computer, damage to a drive, or loss of information, observe these precautions:

Before removing or inserting a hard drive, shut down the computer. If you are unsure whether the computer is off or in Hibernation, turn the computer on, and then shut it down through the operating system.

Before handling a drive, be sure that you are discharged of static electricity. While handling a drive, avoid touching the connector.

Before removing an optical drive, be sure that a disc is not in the drive, and be sure that the optical drive tray is closed.

Handle drives on surfaces covered with at least 2.54 cm (1 inch) of shock-proof foam.

Avoid dropping drives from any height onto any surface.

After removing a hard drive or an optical drive, place it in a static-proof bag.

Avoid exposing an internal hard drive to products that have magnetic fields, such as monitors or speakers.

Avoid exposing a drive to temperature extremes or liquids.

If a drive must be mailed, place the drive in a bubble pack mailer or other suitable form of protective packaging, and label the package "FRAGILE."

Tools required

You need the following tools to complete the removal and replacement procedures:

- Torx T5 screwdriver
- Magnetic Phillips P1 screwdriver
- Nonconductive, nonmarking pry tool

Electrostatic discharge information

A sudden discharge of static electricity from your finger or other conductor can destroy static-sensitive devices or microcircuitry. Often the spark is neither felt nor heard, but damage occurs. An electronic device exposed to electrostatic discharge (ESD) might not appear to be affected at all and can work perfectly throughout a normal cycle. The device might function normally for a while, but it has been degraded in the internal layers, reducing its life expectancy.

Networks built into many integrated circuits provide some protection, but in many cases, the discharge contains enough power to alter device parameters or melt silicon junctions.

IMPORTANT: To prevent damage to the device when you remove or install internal components, observe these precautions:

Keep components in their electrostatic-safe containers until you are ready to install them.

Before touching an electronic component, discharge static electricity by using the guidelines described Personal grounding methods and equipment on page 29.

Avoid touching pins, leads, and circuitry. Handle electronic components as little as possible.

If you remove a component, place it in an electrostatic-safe container.

Generating static electricity

Follow these static electricity guidelines.

- Different activities generate different amounts of static electricity.
- Static electricity increases as humidity decreases.

Table 4-1 Static electricity occurrence based on activity and humidity

Relative humidity			
Event	55%	40%	10%
Walking across carpet	7,500 V	15,000 V	35,000 V
Walking across vinyl floor	3,000 V	5,000 V	12,000 V
Motions of bench worker	400 V	800 V	6,000 V
Removing DIPs (dual in-line packages) from plastic tube	400 V	700 V	2,000 V
Removing DIPs from vinyl tray	2,000 V	4,000 V	11,500 V
Removing DIPs from polystyrene foam	3,500 V	5,000 V	14,500 V
Removing bubble pack from PCB (printed circuit board)	7,000 V	20,000 V	26,500 V
Packing PCBs in foam-lined box	5,000 V	11,000 V	21,000 V
Multiple electric components can be packaged together in plastic tubes, trays, or polystyrene foam.			



NOTE: As little as 700 V can degrade a product.

Preventing electrostatic damage to equipment

Many electronic components are sensitive to ESD. Circuitry design and structure determine the degree of sensitivity. The following packaging and grounding precautions are necessary to prevent static electricity damage to electronic components.

- To avoid hand contact, transport products in static-safe containers such as tubes, bags, or boxes.
- Protect all electrostatic parts and assemblies with conductive or approved containers or packaging.
- Keep electrostatic-sensitive parts in their containers until they arrive at static-free stations.
- Place items on a grounded surface before removing them from their container.
- Always be properly grounded when touching a sensitive component or assembly.
- Avoid contact with pins, leads, or circuitry.
- Place reusable electrostatic-sensitive parts from assemblies in protective packaging or conductive foam.

Personal grounding methods and equipment

Using certain equipment can prevent static electricity damage to electronic components.

- Wrist straps are flexible straps with a maximum of 1 M Ω ±10% resistance in the ground cords. To provide proper ground, a strap must be worn snug against bare skin. The ground cord must be connected and fit snugly into the banana plug connector on the grounding mat or workstation.
- Heel straps/Toe straps/Boot straps can be used at standing workstations and are compatible with most types of shoes or boots. On conductive floors or dissipative floor mats, use them on both feet with a maximum of 1 M Ω ±10% resistance between the operator and ground.

Table 4-2 Static shielding protection levels

Static shielding protection levels	
Method	Voltage
Antistatic plastic	1,500
Carbon-loaded plastic	7,500
Metallized laminate	15,000

Grounding the work area

To prevent static damage at the work area, follow these precautions.

- Cover the work surface with approved static-dissipative material.
- Use a wrist strap connected to a properly grounded work surface and use properly grounded tools and equipment.
- Use static-dissipative mats, foot straps, or air ionizers to give added protection.
- Handle electrostatic sensitive components, parts, and assemblies by the case or PCB laminate. Handle them only at static-free work areas.
- Turn off power and input signals before inserting and removing connectors or test equipment.
- Use fixtures made of static-safe materials when fixtures must directly contact dissipative surfaces.
- Keep the work area free of nonconductive materials, such as ordinary plastic assembly aids and polystyrene foam.
- Use conductive field service tools, such as cutters, screwdrivers, and vacuums.
- Avoid contact with pins, leads, or circuitry.

Recommended materials and equipment

HP recommends certain materials and equipment to prevent static electricity.

- Antistatic tape
- Antistatic smocks, aprons, or sleeve protectors
- Conductive bins and other assembly or soldering aids
- Conductive foam
- Conductive tabletop workstations with ground cord of 1 MΩ ±10% resistance
- Static-dissipative table or floor mats with hard tie to ground
- Field service kits
- Static awareness labels
- Wrist straps and footwear straps providing 1 MΩ ±10% resistance
- Material handling packages
- Conductive plastic bags
- Conductive plastic tubes

- Conductive tote boxes
- Opaque shielding bags
- Transparent metallized shielding bags
- Transparent shielding tubes

Cleaning your computer

Cleaning your computer regularly removes dirt and debris so that your device continues to operate at its best. Use the following information to safely clean the external surfaces of your computer.

Enabling HP Easy Clean (select products only)

HP Easy Clean helps you to avoid accidental input while you clean the computer surfaces. This software disables devices such as the keyboard, touch screen, and touchpad for a preset amount of time so that you can clean all computer surfaces.

- 1. Start HP Easy Clean in one of the following ways:
 - Select the **Start** menu, and then select **HP Easy Clean**.
 - or -
 - Select the HP Easy Clean icon in the taskbar.
 - or -
 - Select **Start**, and then select the **HP Easy Clean** tile.
- Now that your device is disabled for a short period, see Removing dirt and debris from your computer on page 31 for the recommended steps to clean the high-touch, external surfaces on your computer. After you remove the dirt and debris, you can also clean the surfaces with a disinfectant. See Cleaning your computer with a disinfectant on page 32 for guidelines to help prevent the spread of harmful bacteria and viruses.

Removing dirt and debris from your computer

Here are the recommended steps to clean dirt and debris from your computer.

For computers with wood veneer, see Caring for wood veneer (select products only) on page 33.

- 1. Wear disposable gloves made of latex (or nitrile gloves, if you are latex-sensitive) when cleaning the surfaces.
- Turn off your device and unplug the power cord and other connected external devices. Remove any installed batteries from items such as wireless keyboards.
 - CAUTION: To prevent electric shock or damage to components, never clean a product while it is turned on or plugged in.
- 3. Moisten a microfiber cloth with water. The cloth should be moist, but not dripping wet.
- **IMPORTANT:** To avoid damaging the surface, avoid abrasive cloths, towels, and paper towels.
- 4. Wipe the exterior of the product gently with the moistened cloth.

- **IMPORTANT:** Keep liquids away from the product. Avoid getting moisture in any openings. If liquid makes its way inside your HP product, it can cause damage to the product. Do not spray liquids directly on the product. Do not use aerosol sprays, solvents, abrasives, or cleaners containing hydrogen peroxide or bleach that might damage the finish.
- 5. Start with the display (if applicable). Wipe carefully in one direction, and move from the top of the display to the bottom. Finish with any flexible cables, like power cord, keyboard cable, and USB cables.
- 6. Be sure that surfaces have completely air-dried before turning the device on after cleaning.
- 7. Discard the gloves after each cleaning. Clean your hands immediately after you remove the gloves.

See <u>Cleaning your computer with a disinfectant on page 32</u> for recommended steps to clean the high-touch, external surfaces on your computer to help prevent the spread of harmful bacteria and viruses.

Cleaning your computer with a disinfectant

The World Health Organization (WHO) recommends cleaning surfaces, followed by disinfection, as a best practice for preventing the spread of viral respiratory illnesses and harmful bacteria.

After cleaning the external surfaces of your computer using the steps in Removing dirt and debris from your computer on page 31, Caring for wood veneer (select products only) on page 33, or both, you might also choose to clean the surfaces with a disinfectant. A disinfectant that is within HP's cleaning guidelines is an alcohol solution consisting of 70% isopropyl alcohol and 30% water. This solution is also known as rubbing alcohol and is sold in most stores.

Follow these steps when disinfecting high-touch, external surfaces on your computer:

- 1. Wear disposable gloves made of latex (or nitrile gloves, if you are latex-sensitive) when cleaning the surfaces.
- 2. Turn off your device and unplug the power cord and other connected external devices. Remove any installed batteries from items such as wireless keyboards.
 - **CAUTION:** To prevent electric shock or damage to components, never clean a product while it is turned on or plugged in.
- 3. Moisten a microfiber cloth with a mixture of 70% isopropyl alcohol and 30% water. The cloth should be moist, but not dripping wet.
 - CAUTION: Do not use any of the following chemicals or any solutions that contain them, including spray-based surface cleaners: bleach, peroxides (including hydrogen peroxide), acetone, ammonia, ethyl alcohol, methylene chloride, or any petroleum-based materials, such as gasoline, paint thinner, benzene, or toluene.
- **IMPORTANT:** To avoid damaging the surface, avoid abrasive cloths, towels, and paper towels.
- 4. Wipe the exterior of the product gently with the moistened cloth.
- IMPORTANT: Keep liquids away from the product. Avoid getting moisture in any openings. If liquid makes its way inside your HP product, it can cause damage to the product. Do not spray liquids directly on the product. Do not use aerosol sprays, solvents, abrasives, or cleaners containing hydrogen peroxide or bleach that might damage the finish.
- 5. Start with the display (if applicable). Wipe carefully in one direction, and move from the top of the display to the bottom. Finish with any flexible cables, like power cord, keyboard cable, and USB cables.
- Be sure that surfaces have completely air-dried before turning the device on after cleaning.
- 7. Discard the gloves after each cleaning. Clean your hands immediately after you remove the gloves.

Caring for wood veneer (select products only)

Your product might feature high-quality wood veneer. As with all natural wood products, proper care is important for best results over the life of the product. Because of the nature of natural wood, you might see unique variations in the grain pattern or subtle variations in color, which are normal.

- Clean the wood with a dry, static-free microfiber cloth or chamois.
- Avoid cleaning products containing substances such as ammonia, methylene chloride, acetone, turpentine, or other petroleum-based solvents.
- Do not expose the wood to sun or moisture for long periods of time.
- If the wood becomes wet, dry it by dabbing with an absorbent, lint-free cloth.
- Avoid contact with any substance that might dye or discolor the wood.
- Avoid contact with sharp objects or rough surfaces that might scratch the wood.

See Removing dirt and debris from your computer on page 31 for the recommended steps to clean the high-touch, external surfaces on your computer. After you remove the dirt and debris, you can also clean the surfaces with a disinfectant. See Cleaning your computer with a disinfectant on page 32 for sanitizing guidelines to help prevent the spread of harmful bacteria and viruses.

Packaging and transporting guidelines

Follow these grounding guidelines when packaging and transporting equipment.

- To avoid hand contact, transport products in static-safe tubes, bags, or boxes.
- Protect ESD-sensitive parts and assemblies with conductive or approved containers or packaging.
- Keep ESD-sensitive parts in their containers until the parts arrive at static-free workstations.
- Place items on a grounded surface before removing items from their containers.
- Always be properly grounded when touching a component or assembly.
- Store reusable ESD-sensitive parts from assemblies in protective packaging or nonconductive foam.
- Use transporters and conveyors made of antistatic belts and roller bushings. Be sure that mechanized
 equipment used for moving materials is wired to ground and that proper materials are selected to avoid
 static charging. When grounding is not possible, use an ionizer to dissipate electric charges.

Accessing support information

Use this information to find the HP support that you need.

Table 4-3 Support information locations

Service consideration	Path to access information	
Records of reported failure incidents stored	Windows:	
on the computer	Pre-operating system failures are logged in the BIOS Event Log. To view the BIOS Event Log:	
	1. Press the power button.	
	2. Immediately and repeatedly press esc when the power button light turns white.	

Table 4-3 Support information locations (continued)

Service consideration	Path to access information
	NOTE: If you do not press esc at the appropriate time, you must restart the computer and again repeatedly press esc when the power button light turns white to access the utility.
	3. Press f10 to enter the BIOS setup.
	 (On commercial products) Under the Main tab, select BIOS event log, and ther select View BIOS Event Log.
	- or -
	(On consumer products) Under the Main tab, select System Log.
	Post operating system failures are logged in the Event Viewer.
	1. Turn on the computer and allow the operating system to open.
	2. Click the search icon in the taskbar.
	3. Type Event Viewer, and then press enter.
	4. Select the log from the left panel. Details display in the right panel.
	Chrome:
	1. Go to support.google.com/chrome.
	2. Search collect Chrome device logs.
Technical bulletins	To locate technical bulletins:
	1. Go to www.hp.com.
	2. Place the cursor over Problem solving to display more options.
	3. Select Support & Troubleshooting.
	4. Type the serial number, product number, or product name to go to the product support page.
	5. Select Advisories to view technical bulletins.
Repair professionals	To locate repair professionals:
	1. Go to www.hp.com.
	2. Place the cursor over Support resources to display more options.
	3. Select Authorized service providers.
Component and diagnosis information, failure	To locate diagnosis information and actions:
detection, and required action	1. Go to http://www.hp.com/go/techcenter/pcdiags.
	2. Select Get Support .
	Near the bottom of the window, select Notebook PCs, and the select your location.

5 Removal and replacement procedures for authorized service provider parts

This chapter provides removal and replacement procedures for authorized service provider parts.

- **IMPORTANT:** Components described in this chapter should be accessed only by an authorized service provider. Accessing these parts can damage the computer or void the warranty.
- **NOTE:** Details about your computer, including model, serial number, product key, and length of warranty, are on the service tag at the bottom of your computer.

Component replacement procedures

To remove and replace computer components, use these procedures.

NOTE: HP continually improves and changes product parts. For complete and current information about supported parts for your computer, go to http://partsurfer.hp.com, select your country or region, and then follow the on-screen instructions.

You must remove, replace, or loosen as many as 42 screws when you service the parts described in this chapter. Make special note of each screw size and location during removal and replacement.

Preparation for disassembly

To remove and replace computer components, use these procedures.

See Removal and replacement procedures preliminary requirements on page 27 for initial safety procedures.

- 1. Turn off the computer. If you are unsure whether the computer is off or in Hibernation, turn the computer on, and then shut it down through the operating system.
- 2. Disconnect the power from the computer by unplugging the power cord from the computer.
- Disconnect all external devices from the computer.

Bottom cover

To remove the bottom cover, use this procedure and illustration.

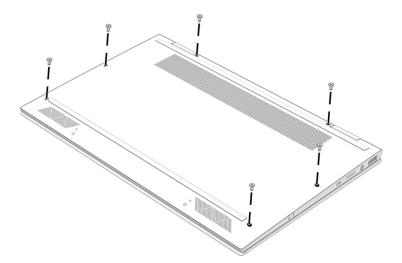
Table 5-1 Bottom cover description and part number

Description	Spare part number
For use only on computer models equipped with WWAN capability	M50566-001
For use only on computer models not equipped with WWAN capability	M50565-001

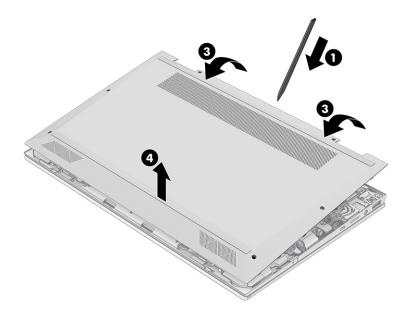
Before removing the bottom cover, prepare the computer for disassembly (see <u>Preparation for disassembly</u> on page 35).

Remove the bottom cover:

1. Remove the six Torx T6M2.0 × 5.0 screws that secure the bottom cover to the computer.



- 2. Use a nonmarking, nonconductive tool (1) to release the rear edge of the bottom cover (2) from the computer.
- 3. Remove the bottom cover from the computer (3).



To replace the bottom cover, reverse the removal procedures.

Battery

To remove the battery, use this procedure and illustration.

Table 5-2 Battery description and part number

Description	Spare part number
Battery	L82391-006

WARNING! To avoid personal injury and damage to the product:

- Do not puncture, twist, or crack the battery.
- Do *not* cause an external puncture or rupture to the battery. They can cause a short inside the battery, which can result in battery thermal runaway.
- Do not handle or touch the battery enclosure with sharp objects such as tweezers or pliers, which might puncture the battery.
- Do not compress or squeeze the battery case with tools or heavy objects stacked on top of the case.
 These actions can apply undue force on the battery.
- Do not touch the connectors with any metallic surface or object, such as metal tools, screws, or coins, which can cause shorting across the connectors.

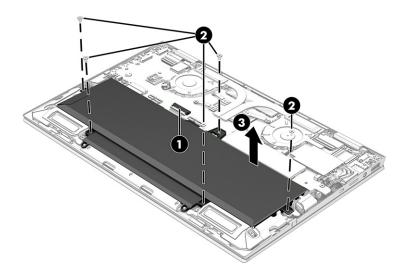
Before removing the battery, follow these steps:

- 1. Prepare the computer for disassembly (see Preparation for disassembly on page 35).
- **2.** Remove the bottom cover (see <u>Bottom cover on page 35</u>).
- **WARNING!** To reduce potential safety issues, use only the user-replaceable battery provided with the computer, a replacement battery provided by HP, or a compatible battery purchased from HP.
- **IMPORTANT:** Removing a battery that is the sole power source for the computer can cause loss of information. To prevent loss of information, save your work or shut down the computer through Windows before you remove the battery.

Remove the battery:

- 1. Disconnect the battery cable (1) from the system board.
- Remove the five Phillips M2.0 × 3.0 screws (2) that secure the battery to the computer.

3. Remove the battery (3) from the computer.



To install the battery, reverse the removal procedures.

Solid-state drive

To remove the M.2 solid-state drive, use this procedure and illustration.

Table 5-3 Solid-state drive descriptions and part numbers

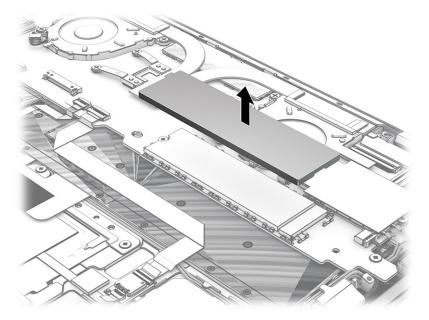
Description	Spare part number
512 GB + 32 GB Optane memory	L85366-001
512 GB, self-encrypting (SED), TLC	L85368-001
512 GB, value	L85364-001
256 GB, TLC, value	L85354-001
256 GB, self-encrypting (SED), TLC	M07245-001
128 GB, TLC	M06792-001

Before removing the solid-state drive, follow these steps:

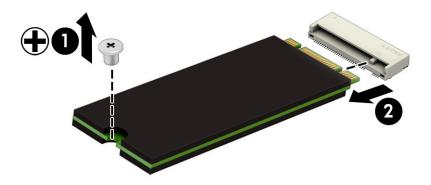
- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- 2. Remove the bottom cover (see Bottom cover on page 35).
- 3. Disconnect the battery cable from the system board (see <u>Battery on page 36</u>).

Remove the solid-state drive:

- 1. Remove the solid-state drive shield from the system board.
- **NOTE:** The solid-state drive shield is not available as a spare part.



- Remove the Phillips PM2.0 × 3.0 screw (1) that secures the solid-state drive to the system board. 2.
- Pull the drive (2) away from the socket to remove it. 3.



To install the solid-state drive, reverse the removal procedures.



WWAN module

To remove the WWAN module, use this procedure and illustration.

Table 5-4 WWAN module descriptions and part numbers

Description	Spare part number
Intel XMM 7360 LTE-Advanced (Cat 9)	L70670-001
Qualcomm Snapdragon X55 LTE + 5G	L83053-001

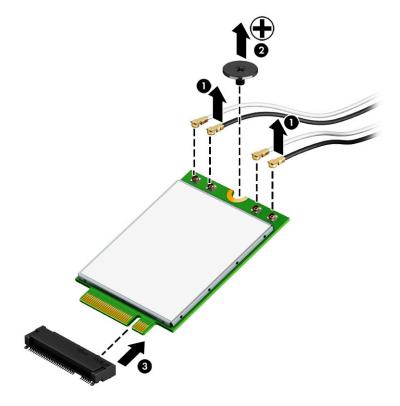
IMPORTANT: To prevent an unresponsive system, replace the wireless module only with a wireless module authorized for use in the computer by the governmental agency that regulates wireless devices in your country or region. If you replace the module and then receive a warning message, remove the module to restore device functionality, and then contact technical support.

Before removing the WWAN module, follow these steps:

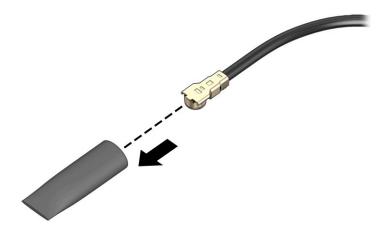
- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- 2. Remove the bottom cover (see Bottom cover on page 35).
- 3. Disconnect the battery cable from the system board (see <u>Battery on page 36</u>).

Remove the WWAN module:

- 1. Disconnect the WWAN antenna cables (1) from the terminals on the WWAN module.
- NOTE: The number of antenna cables can vary.
- 2. Remove the Phillips M2.0 × 3.0 screw (2) that secures the WWAN module to the bottom cover. (The WWAN module tilts up.)
- 3. Remove the WWAN module (3) by pulling the module away from the slot at an angle.



If the WWAN antenna is not connected to the terminal on the WWAN module, a protective sleeve must be installed on the antenna connector, as shown in the following illustration.



Reverse this procedure to install the WWAN module.

Connector board cable

To remove the connector board cable, use this procedure and illustration.

NOTE: The connector board cable is available in the Cable Kit, spare part number M20833-001.

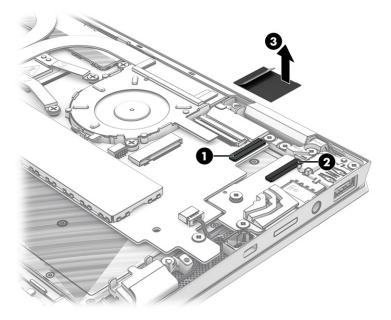
Before removing the connector board cable, follow these steps:

- 1. Prepare the computer for disassembly (see Preparation for disassembly on page 35).
- 2. Remove the bottom cover (see Bottom cover on page 35).
- Disconnect the battery cable from the system board the battery (see <u>Battery on page 36</u>).

Remove the connector board cable:

- Disconnect the cable from the ZIF connector on the system board (1).
- Disconnect the cable from the ZIF connector on the connector board (2). 2.

3. Remove the connector board cable (3).



Reverse this procedure to install the connector board cable.

Connector board

To remove the connector board, use this procedure and illustration.

Table 5-5 Connector board description and part number

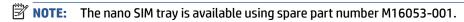
Description	Spare part number
Connector board for use in models with WWAN	M16050-001
Connector board for use in models without WWAN	M23394-001

Before removing the connector board, follow these steps:

- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- 2. Remove the bottom cover (see <u>Bottom cover on page 35</u>).
- 3. Disconnect the battery cable from the system board the battery (see <u>Battery on page 36</u>).
- 4. Remove the WWAN module (see WWAN module on page 39).

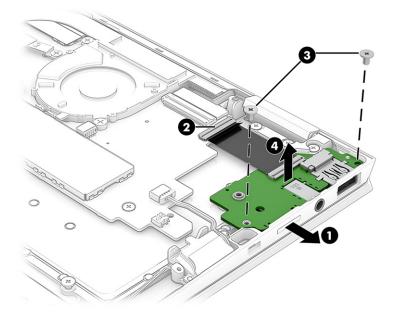
Remove the connector board:

1. Remove the nano SIM tray (1) from the mini media card reader slot.



- 2. Disconnect the cable from the ZIF connector on the system board (1).
- 3. Remove the two Phillips $M2.0 \times 5.0$ screws (3) that secure the connector board to the computer.

4. Remove the connector board (4) and cable.



Reverse this procedure to install the connector board.

Display assembly

To remove and disassemble the display assembly, use these procedures and illustrations.

Table 5-6 Display assembly description and part number

Description	Spare part number
Display assembly, UHD, AMOLED, 400 nits	M45812-001
Display assembly, FHD, antiglare 400 nits	M45810-001
Display assembly, FHD, BrightView, 400 nits	M45811-001
Display assembly, FHD, antiglare, 1000 nits	M45813-001
Display assembly, FHD, BrightView, 1000 nits	M45814-001

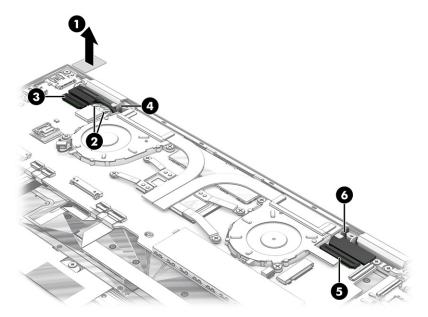
Before removing the display panel, follow these steps:

- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- 2. Remove the bottom cover (see Bottom cover on page 35).
- 3. Disconnect the battery cable from the system board (see <u>Battery on page 36</u>).

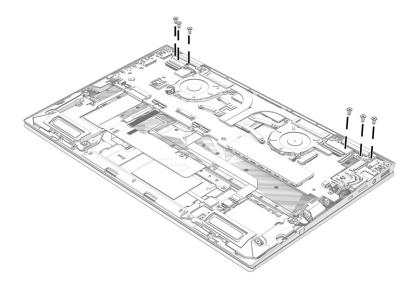
Remove the display assembly:

- 1. Remove the WWAN module shield (1).
- 2. Disconnect the WLAN antenna cables (2) from the WLAN module terminals.
- NOTE: The #1/white WLAN antenna cable connects to the WLAN module #1/Main terminal. The #2/black WLAN antenna cable connects to the WLAN module #2/Aux terminal.

- 3. Release the ZIF connector (3) to which the webcam/microphone module cable is connected, and disconnect the cable from the system board.
- **4.** Release the WLAN antenna cables and the webcam/microphone module cable from the retention clip **(4)** built into the top cover/keyboard.
- **5.** Release the ZIF connector **(5)** to which the display panel cable is connected, and disconnect the cable from the system board.
- 6. Release the display panel cable from the retention clip (6) built into the top cover/keyboard.

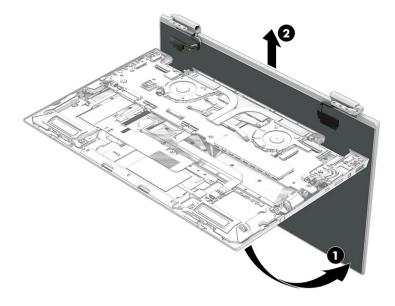


7. Remove the six Phillips M2.0 \times 6.0 screws that secure the display assembly to the computer.



8. Swing the top edge of the display assembly (1) away from the top cover/keyboard. (The top cover/keyboard disengages from the display assembly hinges.)

Separate the display assembly (2) from the top cover/keyboard.



Reverse this procedure to reassemble and replace the display assembly.

Speakers

To remove the speakers, use this procedure and illustration.

Table 5-7 Speaker description and part number

Description	Spare part number
Speakers (includes left and right speakers, cables, and rubber isolators)	M16052-001

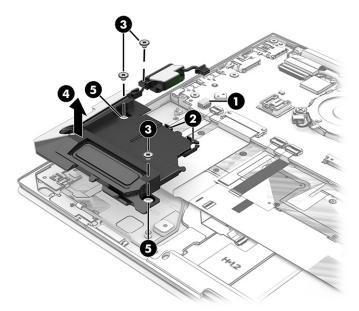
Before removing the speakers, follow these steps:

- Prepare the computer for disassembly (see Preparation for disassembly on page 35).
- 2. Remove the bottom cover (see Bottom cover on page 35).
- 3. Remove the battery (see <u>Battery on page 36</u>).

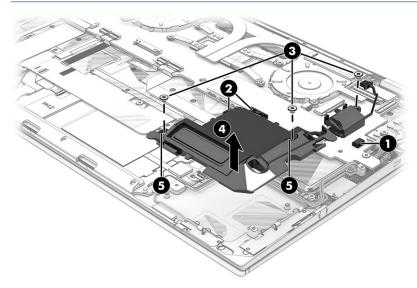
Remove the speakers:

- 1. Detach the keyboard cable from the right speaker. (The keyboard cable is attached to the right speaker with double-side adhesive.)
- 2. Disconnect the right speaker cable (1) from the system board.
- 3. Release the antenna cable from the retention channel (2) built into the right speaker.
- Remove the three Phillips M2.0 × 3.5 screws (3) that secure the right speaker to the computer.

- 5. Remove the right speaker (4).
- **NOTE:** When removing the right speaker, make note of the location of the rubber isolators **(5)**. The absence of or damage to these isolators can result in degraded right speaker performance.



- 6. Disconnect the left speaker cable (1) from the system board.
- 7. Release the antenna cable from the retention channel (2) built into the left speaker.
- **8.** Remove the three Phillips M2.0 \times 3.5 screws (3) that secure the left speaker to the computer.
- 9. Remove the left speaker (4).
- NOTE: When removing the left speaker, make note of the location of the rubber isolators (5). The absence of or damage to these isolators can result in degraded left speaker performance.



Reverse this procedure to install the speakers.

WWAN antenna

To remove the WWAN antenna, use this procedure and illustration.

Table 5-8 WWAN antenna description and part number

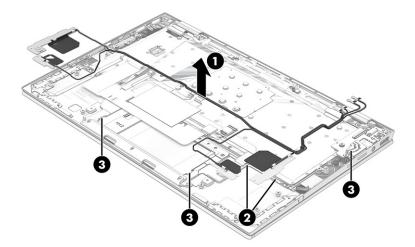
Description	Spare part number
WWAN antenna, models without 5G (includes left and right antennas and cables)	M20834-001
WWAN antenna, models with 5G (includes left and right antennas and cables)	M27525-001

Before removing the WWAN antenna, follow these steps:

- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- 2. Remove the bottom cover (see Bottom cover on page 35).
- 3. Remove the battery (see <u>Battery on page 36</u>).
- 4. Remove the speakers (see Speakers on page 45).

Remove the WWAN antenna:

- Detach the antennas (1) from the top cover/keyboard surface. (The antennas are attached to the top cover/keyboard with double-sided adhesive.)
- 2. Release the cables (2) from the routing path to which they are formed in the top cover/keyboard.
- Release the cables from the rubber retention molds (3).



Remove the WWAN antennas and cables.

Reverse this procedure to install the WWAN antenna.

Touchpad cable

To remove the touchpad cable, use this procedure and illustration.

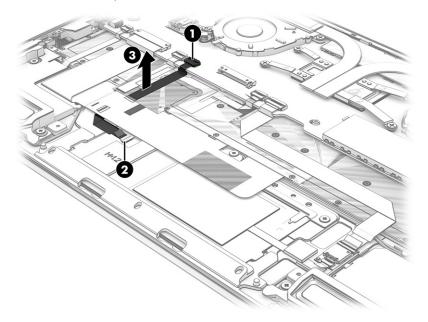
NOTE: The touchpad cable is available in the Cable Kit, spare part number M20833-001.

Before removing the touchpad cable, follow these steps:

- 1. Prepare the computer for disassembly (see Preparation for disassembly on page 35).
- 2. Remove the bottom cover (see <u>Bottom cover on page 35</u>).
- 3. Remove the battery (see <u>Battery on page 36</u>).

Remove the touchpad cable:

- 1. Release the ZIF connector (1) to which the touchpad cable is connected, and then disconnect the cable from the system board.
- **2.** Release the ZIF connector **(2)** to which the touchpad cable is connected, and then disconnect the cable from the touchpad.
- **3.** Remove the touchpad cable **(3)**.



Reverse this procedure to install the touchpad cable.

Touchpad

To remove the touchpad, use this procedure and illustration.

Table 5-9 Touchpad description and part numbers

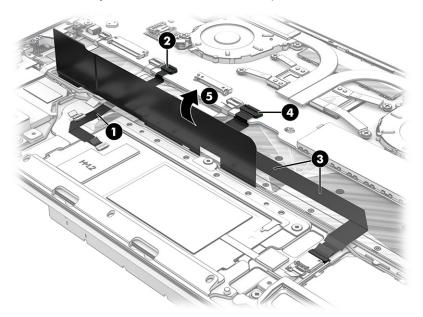
Description	Spare part number
For use only on computer models equipped with NFC capability	M45818-001
For use only on computer models not equipped with NFC capability	M45817-001

Before removing the touchpad, follow these steps:

- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- 2. Remove the bottom cover (see Bottom cover on page 35).
- **3.** Remove the battery (see <u>Battery on page 36</u>).

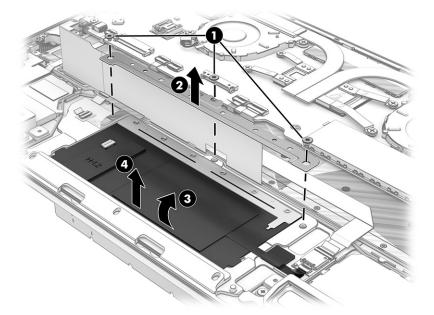
Remove the touchpad:

- 1. Detach the touchpad cable (1) from the top cover/keyboard. (The touchpad cable is attached to the top cover/keyboard with double-sided adhesive.)
- **2.** Release the ZIF connector **(2)** to which the touchpad cable is connected, and then disconnect the cable from the system board.
 - Steps 3 and 4 apply only to computer models equipped with an NFC module and cable.
- **3.** Detach the NFC module cable **(3)** from the top cover/keyboard. (The NFC module cable is attached to the top cover/keyboard with double-sided adhesive.)
- **4.** Release the ZIF connector **(4)** to which the NFC module cable is connected, and then disconnect the cable from the system board.
- 5. Fold back the keyboard cable (5) until the touchpad screws are accessible.



- 6. Remove the three Phillips M2.0 × 2.0 broad head screws (1) that secure the touchpad to the computer.
- **7.** Remove the touchpad bracket **(2)**.
- **8.** Lift the front edge **(3)** of the touchpad until it clears the top cover/keyboard.

9. Remove the touchpad from the computer (4).



Reverse this procedure to install the touchpad.

NFC module cable

To remove the NFC module cable, use this procedure and illustration.

NOTE: The NFC module cable is available in the Cable Kit, spare part number M20833-001.

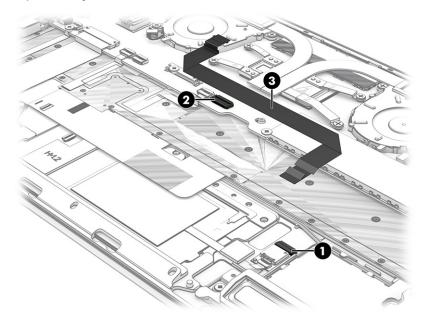
Before removing the NFC module cable, follow these steps:

- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- 2. Remove the bottom cover (see <u>Bottom cover on page 35</u>).
- 3. Remove the battery (see <u>Battery on page 36</u>).

Remove the NFC module cable:

- 1. Disconnect the cable from the ZIF connector on the NFC module (1).
- 2. Disconnect the cable from the ZIF connector on the system board (2).

Detach the NFC module cable (3) from the top cover/keyboard. (The NFC module cable is attached to the top cover/keyboard with double-sided adhesive.)



4. Remove the NFC module cable.

Reverse this procedure to install the NFC module cable.

NFC module

To remove the NFC module, use this procedure and illustration.

Table 5-10 NFC module cable description and part number

Description	Spare part number
NFC module	M16045-001
NOTE: The NFC module cable is available in the Cable Kit, spare part number M20833-001.	

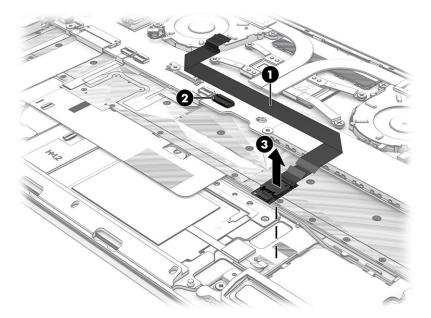
Before removing the NFC module, follow these steps:

- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- 2. Remove the bottom cover (see <u>Bottom cover on page 35</u>).
- **3.** Remove the battery (see <u>Battery on page 36</u>).

Remove the NFC module:

- 1. Detach the NFC module cable (1) from the top cover/keyboard. (The NFC module cable is attached to the top cover/keyboard with double-sided adhesive.)
- 2. Disconnect the cable from the ZIF connector on the system board (2).

3. Detach the NFC module from the top cover/keyboard (3). (The NFC module cable is attached to the top cover/keyboard with double-sided adhesive.)



Reverse this procedure to install the NFC module.

System board

To remove the system board, use these procedures and illustrations.

Table 5-11 System board descriptions and part numbers

Description	Spare part number
NOTE: All system board spare part kits include replacement thermal material.	
All system boards use the following part numbers:	
xxxxxx-001: Non-Windows operating systems	
xxxxxx-601: Windows operating system	
Intel Core i7-1185G7 processor with 32 GB of system memory (OSR)	M45838-xx1
Intel Core i7-1185G7 processor with 16 GB of system memory (OSR)	M45837-xx1
Intel Core i7-1185G7 processor with 16 GB of system memory	M45835-xx1
Intel Core i7-1185G7 processor with 8 GB of system memory (OSR)	M45836-xx1
Intel Core i7-1165G7 processor with 16 GB of system memory (OLED)	M45834-xx1
Intel Core i7-1165G7 processor with 16 GB of system memory	M45833-xx1
Intel Core i7-1165G7 processor with 8 GB of system memory	M45832-xx1
Intel Core i5-1145G7 processor with 16 GB of system memory (OSR)	M45831-xx1
Intel Core i5-1145G7 processor with 16 GB of system memory	M45829-xx1
Intel Core i5-1145G7 processor with 8 GB of system memory (OSR)	M45830-xx1
Intel Core i5-1145G7 processor with 8 GB of system memory	M45828-xx1

Table 5-11 System board descriptions and part numbers (continued)

Description	Spare part number
Intel Core i5-1135G7 processor with 16 GB of system memory (OLED)	M45827-xx1
Intel Core i5-1135G7 processor with 16 GB of system memory	M45826-xx1
Intel Core i3-1135G7 processor with 8 GB of system memory	M45825-xx1

Before removing the system board, follow these steps:

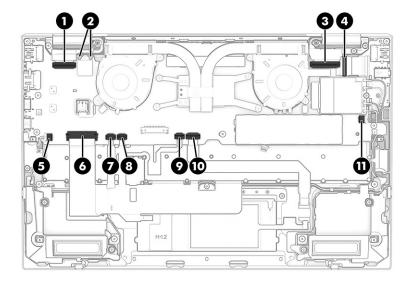
- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- **2.** Remove the bottom cover (see <u>Bottom cover on page 35</u>).
- 3. Remove the battery (see <u>Battery on page 36</u>).
- 4. Remove the WWAN module (see WWAN module on page 39).

When you replace the system board, be sure to remove the following components (as applicable) from the defective system board and install them on the replacement system board:

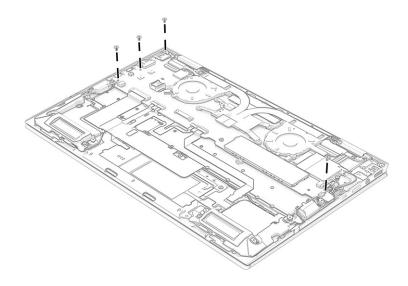
- Solid-state drive and shield (see Solid-state drive on page 38).
- Fan/heat sink assembly (see <u>Fan/heat sink assembly on page 55</u>).
- Sensor board and cable (see Sensor board on page 57).

Remove the system board:

- 1. Disconnect the following cables from the system board:
 - Camera/microphone module cable (1)
 - WLAN module shield and WLAN antenna cables from the WLAN module (2)
 - Display panel cable ZIF connector (3)
 - USB board cable (4)
 - Right speaker cable (5)
 - Keyboard cable ZIF connector (6)
 - Fingerprint sensor cable ZIF connector (7)
 - Touchpad cable ZIF connector (8)
 - Backlight cable ZIF connector (9)
 - NFC module cable ZIF connector (10)
 - Left speaker cable (11)

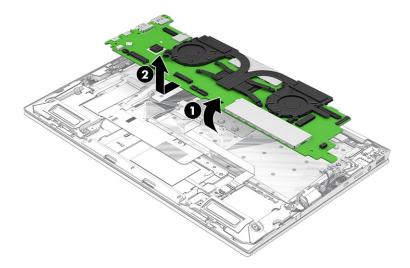


2. Remove the four Phillips M2.0 \times 3.0 screws that secure the system board to the computer.



3. Lift the front edge of the system board (1) until it rests at an angle.

4. Remove the system board (2) by sliding it up and forward at an angle.



Reverse this procedure to install the system board.

Fan/heat sink assembly

To remove the fan/heat sink assembly, use these procedures and illustrations.

Table 5-12 Fan/heat sink assembly descriptions and part number

Description	Spare part number
Fan/heat sink assembly (includes replacement thermal material and fan cables)	M45823-001

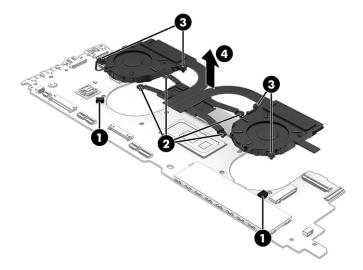
Before removing the fan/heat sink assembly, follow these steps:

- 1. Prepare the computer for disassembly (see Preparation for disassembly on page 35).
- 2. Remove the bottom cover (see Bottom cover on page 35).
- 3. Remove the battery (see Battery on page 36).
- **4.** Remove the system board (see <u>System board on page 52</u>).

Remove the fan/heat sink assembly:

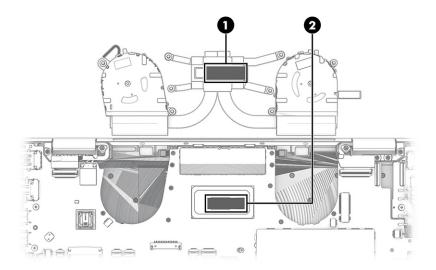
- 1. Disconnect the fan cables (1) from the system board.
- 2. In the order indicated on the fan/heat sink assembly, remove the four captive Phillips screws (2) that secure the fan/heat sink assembly to the system board.
- 3. Loosen the four captive Phillips screws (3) that secure the fan/heat sink assembly to the system board.

4. Remove the fan/heat sink assembly (4) from the system board (2).



5. Thoroughly clean the thermal material from the surfaces of the fan/heat sink assembly and the system board components each time the fan/heat sink assembly is removed. Replacement thermal material is included with the fan/heat sink assembly and system board spare part kits. The following illustration shows the replacement thermal material locations.

Thermal paste is used on the processor (1) and on the fan/heat sink assembly area (2) that services it.



Reverse this procedure to install the fan/heat sink assembly.

Sensor board cable

To remove the sensor board cable, use this procedure and illustration.

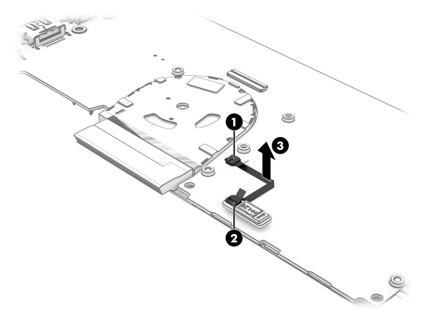
Before removing the sensor board cable, follow these steps:

- 1. Prepare the computer for disassembly (see Preparation for disassembly on page 35).
- 2. Remove the bottom cover (see <u>Bottom cover on page 35</u>).
- **3.** Remove the battery (see <u>Battery on page 36</u>).

- 4. Remove the WWAN module (see <u>WWAN module on page 39</u>).
- **5.** Remove the system board (see <u>System board on page 52</u>).

Remove the sensor board cable:

- 1. Turn the system board upside down with the rear toward you.
- **2.** Disconnect the cable from the ZIF connector on the system board **(1)**.
- 3. Disconnect the cable from the ZIF connector on the sensor board (2).
- 4. Remove the sensor board cable (3).



Reverse this procedure to install the sensor board cable.

Sensor board

To remove the sensor board, use this procedure and illustration.

Table 5-13 Sensor board description and part number

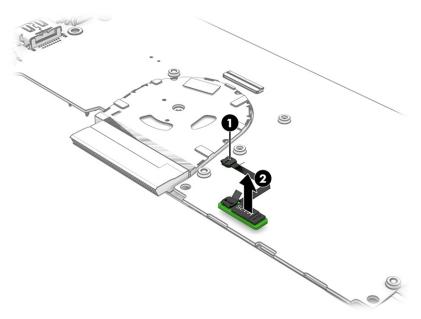
Description	Spare part number
Sensor board	M45824-001

Before removing the sensor board, follow these steps:

- 1. Prepare the computer for disassembly (see <u>Preparation for disassembly on page 35</u>).
- **2.** Remove the bottom cover (see <u>Bottom cover on page 35</u>).
- 3. Remove the battery (see <u>Battery on page 36</u>).
- 4. Remove the WWAN module (see WWAN module on page 39).
- Remove the system board (see <u>System board on page 52</u>).

Remove the sensor board:

- 1. Turn the system board upside down with the rear toward you.
- 2. Disconnect the cable from the ZIF connector on the system board (1).
- **3.** Detach the sensor board **(2)** from the system board. (The sensor board is attached to the system board with double-sided adhesive.)



Reverse this procedure to install the sensor board.

Top cover with keyboard

The top cover with keyboard remains after removing all other spare parts from the computer. In this section, the first table provides the main spare part number for the top cover/keyboards. The second table provides the country codes.

Table 5-14 Top cover with keyboard descriptions and part numbers

Description	Spare part number
Backlit, models without WWAN	M45819-xx1
Backlit, privacy, models without WWAN	M45820-xx1
Backlit, models with WWAN	M45821-xx1
Backlit, privacy, models with WWAN	M45822-xx1

Table 5-15 Spare part country codes

For use in country or region	Spare part number	For use in country or region	Spare part number	For use in country or region	Spare part number
Belgium	-A41	Hungary	-211	Saudi Arabia	-171
Brazil	-201	Iceland	-DD1	Slovenia	-BA1
Bulgaria	-261	India	-D61	South Korea	-AD1
Chile	-161	Israel	-BB1	Spain	-071

Table 5-15 Spare part country codes (continued)

For use in country or region	Spare part number	For use in country or region	Spare part number	For use in country or region	Spare part number
Czech Republic/Slovakia	-FL1	Italy	-061	Switzerland	-BG1
Denmark	-081	Japan	-291	Taiwan	-AB1
Denmark, Finland, and Norway	-DH1	The Netherlands	-B31	Thailand	-281
French Canada	-DB1	Northern Africa	-FP1	Turkey	-141
Finland/Sweden	-B71	Norway	-091	Turkey-F	-541
France	-051	Portugal	-131	Ukraine	-BD1
Germany	-041	Romania	-271	United Kingdom	-031
Greece	-151	Russia	-251	United States	-001

Computer Setup (BIOS), TPM, and HP Sure 6 Start

HP provides several tools to help set up and protect your computer.

Using Computer Setup

Computer Setup, or Basic Input/Output System (BIOS), controls communication between all the input and output devices on the system (such as hard drives, display, keyboard, mouse, and printer). Computer Setup includes settings for types of devices installed, the startup sequence of the computer, and amount of system and extended memory.



NOTE: Use extreme care when making changes in Computer Setup. Errors can prevent the computer from operating properly.

To start Computer Setup, turn on or restart the computer, and when the HP logo appears, press f10 to enter Computer Setup.

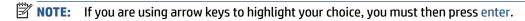
Navigating and selecting in Computer Setup

You can navigate and select in Computer Setup using one or more methods.

- To select a menu or a menu item, use the tab key and the keyboard arrow keys and then press enter, or use a pointing device to select the item.
- To scroll up and down, select the up arrow or the down arrow in the upper-right corner of the screen, or use the up arrow key or the down arrow key on the keyboard.
- To close open dialog boxes and return to the main Computer Setup screen, press esc, and then follow the on-screen instructions.

To exit Computer Setup, choose one of the following methods:

To exit Computer Setup menus without saving your changes, select Main, select Ignore Changes and Exit. and then select Yes.



To save your changes and exit Computer Setup menus, select **Main**, select **Save Changes and Exit**, and then select Yes.



Your changes go into effect when the computer restarts.

Restoring factory settings in Computer Setup

To return all settings in Computer Setup to the values that were set at the factory, follow these steps.



NOTE: Restoring defaults will not change the hard drive mode.

- Start Computer Setup. See Using Computer Setup on page 60.
- 2. Select Main, select Apply Factory Defaults and Exit, and then select Yes.
 - NOTE: If you are using arrow keys to highlight your choice, you must then press enter.
- NOTE: On select products, the selections might display **Restore Defaults** instead of **Apply Factory Defaults and Exit**.

Your changes go into effect when the computer restarts.

NOTE: Your password settings and security settings are not changed when you restore the factory settings.

Updating the BIOS

Updated versions of the BIOS might be available on the HP website. Most BIOS updates on the HP website are packaged in compressed files called *SoftPaqs*.

Some download packages contain a file named Readme.txt, which contains information regarding installing and troubleshooting the file.

Determining the BIOS version

To decide whether you need to update Computer Setup (BIOS), first determine the BIOS version on your computer.

You can access BIOS version information (also known as *ROM date* and *System BIOS*) by pressing fn+esc (if you are already in Windows) or by using Computer Setup.

- Start Computer Setup. See Using Computer Setup on page 60.
- 2. Select Main, and then select System Information.
- To exit Computer Setup menus without saving your changes, select Main, select Ignore Changes and Exit. and then select Yes.
- NOTE: If you are using arrow keys to highlight your choice, you must then press enter.

To check for later BIOS versions, see Preparing for a BIOS update on page 61.

Preparing for a BIOS update

Be sure to follow all prerequisites before downloading and installing a BIOS update.

IMPORTANT: To reduce the risk of damage to the computer or an unsuccessful installation, download and install a BIOS update only when the computer is connected to reliable external power using the AC adapter. Do not download or install a BIOS update while the computer is running on battery power, docked in an optional docking device, or connected to an optional power source. During the download and installation, follow these instructions:

Do not disconnect power on the computer by unplugging the power cord from the AC outlet.

Do not shut down the computer or initiate Sleep.

Do not insert, remove, connect, or disconnect any device, cable, or cord.

Downloading a BIOS update

After you review the prerequisites, you can check for and download BIOS updates.

Type support in the taskbar search box, and then select the HP Support Assistant app.

- or -

Select the question mark icon in the taskbar.

- 2. Select **Updates**, and then select **Check for updates and messages**.
- Follow the on-screen instructions.
- **4.** At the download area, follow these steps:
 - a. Identify the most recent BIOS update and compare it to the BIOS version currently installed on your computer. Make a note of the date, name, or other identifier. You might need this information to locate the update later, after it has been downloaded to your hard drive.
 - **b.** Follow the on-screen instructions to download your selection to the hard drive.

Make a note of the path to the location on your hard drive where the BIOS update is downloaded. You will need to access this path when you are ready to install the update.

NOTE: If you connect your computer to a network, consult the network administrator before installing any software updates, especially system BIOS updates.

Installing a BIOS update

BIOS installation procedures vary. Follow any instructions that are displayed on the screen after the download is complete. If no instructions are displayed, follow these steps.

- 1. Type file in the taskbar search box, and then select **File Explorer**.
- Select your hard drive designation. The hard drive designation is typically Local Disk (C:).
- Using the hard drive path you recorded earlier, open the folder that contains the update.
- Double-click the file that has an .exe extension (for example, *filename*.exe).
 The BIOS installation begins.
- 5. Complete the installation by following the on-screen instructions.

NOTE: After a message on the screen reports a successful installation, you can delete the downloaded file from your hard drive.

Changing the boot order using the f9 prompt

To dynamically choose a boot device for the current startup sequence, follow these steps.

- 1. Access the Boot Device Options menu:
 - Turn on or restart the computer, and when the HP logo appears, press f9 to enter the Boot Device Options menu.
- **2.** Select a boot device, press enter, and then follow the on-screen instructions.

TPM BIOS settings (select products only)

TPM provides additional security for your computer. You can modify the TPM settings in Computer Setup (BIOS).

IMPORTANT: Before enabling Trusted Platform Module (TPM) functionality on this system, you must ensure that your intended use of TPM complies with relevant local laws, regulations and policies, and approvals or licenses must be obtained if applicable. For any compliance issues arising from your operation or usage of TPM that violates the previously mentioned requirement, you shall bear all the liabilities wholly and solely. HP will not be responsible for any related liabilities.

NOTE: If you change the TPM setting to Hidden, TPM is not visible in the operating system.

To access TPM settings in Computer Setup:

- Start Computer Setup. See <u>Using Computer Setup on page 60</u>.
- Select **Security**, select **TPM Embedded Security**, and then follow the on-screen instructions.

Using HP Sure Start (select products only)

Select computer models are configured with HP Sure Start, a technology that monitors the computer's BIOS for attacks or corruption. If the BIOS becomes corrupted or is attacked, HP Sure Start automatically restores the BIOS to its previously safe state, without user intervention.

HP Sure Start is configured and already enabled so that most users can use the HP Sure Start default configuration. Advanced users can customize the default configuration.

To access the latest documentation on HP Sure Start, go to http://www.hp.com/support. Select Find your **product**, and then follow the on-screen instructions.

7 Backing up, restoring, and recovering

You can use Windows tools or HP software to back up your information, create a restore point, reset your computer, create recovery media, or restore your computer to its factory state. Performing these standard procedures can return your computer to a working state faster.

IMPORTANT: If you will be performing recovery procedures on a tablet, the tablet battery must be at least 70% charged before you start the recovery process.

IMPORTANT: For a tablet with a detachable keyboard, connect the tablet to the keyboard base before beginning any recovery process.

Backing up information and creating recovery media

These methods of creating recovery media and backups are available on select products only.

Using Windows tools for backing up

HP recommends that you back up your information immediately after initial setup. You can do this task either using Windows Backup locally with an external USB drive or using online tools.

- IMPORTANT: Windows is the only option that allows you to back up your personal information. Schedule regular backups to avoid information loss.
- NOTE: If computer storage is 32 GB or less, Microsoft® System Restore is disabled by default.

Using the HP Cloud Recovery Download Tool to create recovery media (select products only)

You can use the HP Cloud Recovery Download Tool to create HP Recovery media on a bootable USB flash drive.

For details:

- ▲ Go to http://www.hp.com/support, search for HP Cloud Recovery, and then select the result that matches the type of computer that you have.
- NOTE: If you cannot create recovery media yourself, contact support to obtain recovery discs. Go to http://www.hp.com/support, select your country or region, and then follow the on-screen instructions.
- **IMPORTANT:** HP recommends that you follow the <u>Restoring and recovery methods on page 65</u> to restore your computer before you obtain and use the HP recovery discs. Using a recent backup can return your machine to a working state sooner than using the HP recovery discs. After the system is restored, reinstalling all the operating system software released since your initial purchase can be a lengthy process.

Restoring and recovering your system

You have several tools available to recover your system both within and outside of Windows if the desktop cannot load.

HP recommends that you attempt to restore your system using the <u>Restoring and recovery methods</u> on page 65.

Creating a system restore

System Restore is available in Windows. The System Restore software can automatically or manually create restore points, or snapshots, of the system files and settings on the computer at a particular point.

When you use System Restore, it returns your computer to its state at the time you made the restore point. Your personal files and documents should not be affected.

Restoring and recovery methods

After you run the first method, test to see whether the issue still exists before you proceed to the next method, which might now be unnecessary.

- Run a Microsoft System Restore.
- Run Reset this PC. 2.
 - **NOTE:** The options **Remove everything** and then **Fully clean the drive** can take several hours to complete and leave no information on your computer. It is the safest way to reset your computer before you recycle it.
- Recover using HP Recovery media. For more information, see Recovering using HP Recovery media on page 65.

For more information about the first two methods, see the Get Help app:

Select the **Start** button, select the **Get Help** app, and then enter the task you want to perform.



NOTE: You must be connected to the internet to access the Get Help app.

Recovering using HP Recovery media

You can use HP Recovery media to recover the original operating system and software programs that were installed at the factory. On select products, it can be created on a bootable USB flash drive using the HP Cloud Recovery Download Tool.

For details, see Using the HP Cloud Recovery Download Tool to create recovery media (select products only) on page 64.



NOTE: If you cannot create recovery media yourself, contact support to obtain recovery discs. Go to http://www.hp.com/support, select your country or region, and then follow the on-screen instructions.

To recover your system:

Insert the HP Recovery media, and then restart the computer.



NOTE: HP recommends that you follow the Restoring and recovery methods on page 65 to restore your computer before you obtain and use the HP recovery discs. Using a recent backup can return your machine to a working state sooner than using the HP recovery discs. After the system is restored, reinstalling all the operating system software released since your initial purchase can be a lengthy process.

Changing the computer boot order

If your computer does not restart using the HP Recovery media, you can change the computer boot order, the order of devices listed in BIOS for startup information. You can select an optical drive or a USB flash drive, depending on the location of your HP Recovery media.

IMPORTANT: For a tablet with a detachable keyboard, connect the tablet to the keyboard base before beginning these steps.

To change the boot order:

- 1. Insert the HP Recovery media.
- 2. Access the system **Startup** menu.
 - For computers or tablets with keyboards attached, turn on or restart the computer or tablet, quickly press esc, and then press f9 for boot options.
 - For tablets without keyboards, turn on or restart the tablet, quickly press and hold the volume up button, and then select f9.

- or -

Turn on or restart the tablet, quickly press and hold the volume down button, and then select f9.

3. Select the optical drive or USB flash drive from which you want to boot, and then follow the on-screen instructions.

Using HP Sure Recover (select products only)

Select computer models are configured with HP Sure Recover, a PC operating system (OS) recovery solution built into the hardware and software. HP Sure Recover can fully restore the HP OS image without installed recovery software.

Using HP Sure Recover, an administrator or user can restore the system and install:

- Latest version of the operating system
- Platform-specific device drivers
- Software applications, in the case of a custom image

To access the latest documentation for HP Sure Recover, go to http://www.hp.com/support. Follow the onscreen instructions to find your product and locate your documentation.

8 **Specifications**

This chapter provides specifications for your computer.

Computer specifications

This section provides specifications for your computer. When traveling with your computer, the computer dimensions and weights, as well as input power ratings and operating specifications, provide helpful information.

Table 8-1 Computer specifications

	Metric	U.S.
Dimensions		
Width	303.76 mm	11.97 in
Depth	193.90 mm	764 in
Height	16.10 mm	0.63 in
Veight	1.22 kg	2.68 lb
Input power		
Operating voltage and current	19.5 V dc @ 3.33 A – 65 W	
Temperature		
Operating	5°C to 35°C	41°F to 95°F
lonoperating	-20°C to 60°C	–4°F to 140°F
elative humidity (noncondensing)		
Operating	10% to 90%	
Nonoperating	5% to 95%	
Maximum altitude (unpressurized)		
Operating	–15 m to 3,048 m	−50 ft to 10,000 ft
Nonoperating	–15 m to 12,192 m	-50 ft to 40,000 ft

33.8 cm (13.3 in) display specifications

This section provides specifications for your display.

Table 8-2 Display specifications

	Metric	U.S.
Active diagonal size	33.8 cm	13.3 in

Table 8-2 Display specifications (continued)

	Metric	U.S.
Resolution	1920 × 1080 (FHD)	
	3840 × 2160 (UHD)	
Surface treatment	Antiglare	
	BrightView	
Brightness	400 nits	
	1000 nits	
Viewing angle	UWVA	
Backlight	WLED	
Display panel interface	eDP 1.4 + PSR2	

Solid-state drive specifications

This section provides specifications for your solid-state drives.

Table 8-3 Solid-state drive specifications

	120 CP*	3FC CD*	F12 CD*
	128 GB*	256 GB*	512 GB*
Dimensions			
Height	1.0 mm	1.0 mm	1.0 mm
Length	50.8 mm	50.8 mm	50.8 mm
Width	28.9 mm	28.9 mm	28.9 mm
Weight	< 10 g	< 10 g	< 10 g
Interface type	PCIe	PCle	PCIe
Ready time, maximum (to not busy)	1.0 ms	1.0 ms	< 1.0 ms
Access times, logical	1.0 ms	0.1 ms	0.1 ms
Transfer rate			
Sequential read	up to 2150 MB/s	up to 2150 MB/s	up to 2150 MB/s
Random read	Up to 300,000 IOPs	Up to 300,000 IOPs	Up to 300,000 IOPs
Sequential write	up to 1550 MB/s	up to 1550 MB/s	up to 1550 MB/s
Random write	Up to 100,000 IOPs	Up to 100,000 IOPs	Up to 100,000 IOPs
Total logical sectors	234,441,648	468,883,296	1,000,215,216
Operating temperature	0°C to 70°C (32°F to 1	0°C to 70°C (32°F to 158°F)	

^{*1} GB = 1 billion bytes when referring to hard drive storage capacity. Actual accessible capacity is less. Actual drive specifications can differ slightly.

NOTE: Certain restrictions and exclusions apply. Contact support for details.

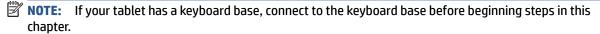
9 Statement of memory volatility

For general information regarding nonvolatile memory in HP business computers, and to restore nonvolatile memory that can contain personal data after the system has been turned off and the hard drive has been removed, use these instructions.

HP business computer products that use Intel®-based or AMD®-based system boards contain volatile DDR memory. The amount of nonvolatile memory present in the system depends upon the system configuration. Intel-based and AMD-based system boards contain nonvolatile memory subcomponents as originally shipped from HP, with the following assumptions:

- No subsequent modifications were made to the system.
- No applications, features, or functionality were added to or installed on the system.

Following system shutdown and removal of all power sources from an HP business computer system, personal data can remain on volatile system memory (DIMMs) for a finite period of time and also remains in nonvolatile memory. Use the following steps to remove personal data from the computer, including the nonvolatile memory found in Intel-based and AMD-based system boards.



Current BIOS steps

Use these instructions to restore nonvolatile memory.

- Follow these steps to restore the nonvolatile memory that can contain personal data. Restoring or reprogramming nonvolatile memory that does not store personal data is neither necessary nor recommended.
 - **a.** Turn on or restart the computer, and then quickly press esc.
 - **NOTE:** If the system has a BIOS administrator password, enter the password at the prompt.
 - **b.** Select **Main**, select **Apply Factory Defaults and Exit**, and then select **Yes** to load defaults. The computer restarts.
 - **c.** During the restart, press esc while the "Press the ESC key for Startup Menu" message is displayed at the bottom of the screen.
 - NOTE: If the system has a BIOS administrator password, enter the password at the prompt.
 - Select the Security menu, select Restore Security Settings to Factory Defaults, and then select
 Yes to restore security level defaults. The computer reboots.
 - During the reboot, press esc while the "Press the ESC key for Startup Menu" message is displayed at the bottom of the screen.
 - NOTE: If the system has a BIOS administrator password, enter the password at the prompt.
 - **f.** If an asset or ownership tag is set, select the **Security** menu and scroll down to the **Utilities** menu. Select **System IDs**, and then select **Asset Tracking Number**. Clear the tag, and then make the selection to return to the prior menu.

- g. If a DriveLock password is set, select the Security menu, and scroll down to Hard Drive Utilities under the Utilities menu. Select Hard Drive Utilities, select DriveLock, and then clear the check box for DriveLock password on restart. Select OK to proceed.
- h. Select the Main menu, and then select Reset BIOS Security to factory default. Select Yes at the warning message. The computer reboots.
- During the reboot, press esc while the "Press the ESC key for Startup Menu" message is displayed at the bottom of the screen.
 - **NOTE:** If the system has a BIOS administrator password, enter the password at the prompt.
- j. Select the **Main** menu, select **Apply Factory Defaults and Exit**, select **Yes** to save changes and exit, and then select **Shutdown**.
- **k.** Reboot the system. If the system has a Trusted Platform Module (TPM), fingerprint reader, or both, one or two prompts will appear—one to clear the TPM and the other to Reset Fingerprint Sensor. Press or tap f1 to accept or f2 to reject.
- **l.** Remove all power and system batteries for at least 24 hours.
- 2. Complete one of the following:
 - Remove and retain the storage drive.
 - or –
 - Clear the drive contents by using a third-party utility designed to erase data from an SSD.
 - or -
 - Clear the contents of the drive by using the following BIOS Setup Secure Erase command option steps:

If you clear data using Secure Erase, you cannot recover it.

- **a.** Turn on or restart the computer, and then quickly press esc.
- **b.** Select the **Security** menu and scroll down to the esc menu.
- c. Select Hard Drive Utilities.
- **d.** Under **Utilities**, select **Secure Erase**, select the hard drive storing the data you want to clear, and then follow the on-screen instructions to continue.
 - or -

Clear the contents of the drive using the following Disk Sanitizer commands steps:

- **i.** Turn on or restart the computer, and then quickly press esc.
- ii. Select the **Security** menu and scroll down to the **Utilities** menu.
- iii. Select Hard Drive Utilities.
- iv. Under **Utilities**, select **Disk Sanitizer**, select the hard drive with the data that you want to clear, and then follow the on-screen instructions to continue.
- NOTE: The amount of time it takes for Disk Sanitizer to run can take several hours. Plug the computer into an AC outlet before starting.

Nonvolatile memory usage

Use this table to troubleshooting nonvolatile memory usage.

Table 9-1 Troubleshooting steps for nonvolatile memory usage

Nonvolatile memory type	Amount (Size)	Does this memory store customer data?	Does this memory retain data when power is removed?	What is the purpose of this memory?	How is data entered into this memory?	How is this memory write-protected?
HP Sure Start flash (select models only)	8 MB	No	Yes	Provides protected backup of critical System BIOS code, EC firmware, and critical computer configuration data for select platforms that support HP Sure Start.	Data cannot be written to this device via the host processor. The content is managed solely by the HP Sure Start Embedded Controller.	This memory is protected by the HP Sure Start Embedded Controller.
				For more information, see <u>Using HP</u> <u>Sure Start</u> (select products only) on page 74.		
Real Time Clock (RTC) battery backed-up CMOS configuration memory	256 bytes	No	Yes	Stores system date and time and noncritical data.	RTC battery backed-up CMOS is programmed using Computer Setup (BIOS), or by changing the Windows date & time.	This memory is not write- protected.
Controller (NIC) EEPROM	64 KB (not customer accessible)	No	Yes	Stores NIC configuration and NIC firmware.	NIC EEPROM is programmed using a utility from the NIC vendor that can be run from DOS.	A utility must be used to write data to this memory and is available from the NIC vendor. Writing data to this ROM in an inappropriate manner will render the NIC nonfunctional.
DIMM Serial Presence Detect (SPD) configuration data	256 bytes per memory module, 128 bytes programmable (not customer accessible)	No	Yes	Stores memory module information.	DIMM SPD is programmed by the memory vendor.	Data cannot be written to this memory when the module is installed in a computer. The specific write-protection method varies by memory vendor.
System BIOS	9 MB	Yes	Yes	Stores system BIOS code and computer configuration data.	System BIOS code is programmed at the factory. Code is updated when the system BIOS is updated. Configuration data and settings are entered using the Computer Setup (BIOS) or a custom utility.	NOTE: Writing data to this ROM in an inappropriate manner can render the computer nonfunctional. A utility must be used for writing data to this memory and is available

Table 9-1 Troubleshooting steps for nonvolatile memory usage (continued)

Nonvolatile memory type	Amount (Size)	Does this memory store customer data?	Does this memory retain data when power is removed?	What is the purpose of this memory?	How is data entered into this memory?	How is this memory write-protected?
						on the HP website; go to http://www.hp.com/support. Select Find your product, and then follow the on-screen instructions.
Intel Management Engine Firmware (present only in select Elite or Z models. For more information, go to http://www.hp.com/ support. Select Identify your product for manuals and specific product information, and then follow the on-screen instructions.)	1.5 MB or 7 MB	Yes	Yes	Stores Management Engine Code, Settings, Provisioning Data and iAMT third-party data store.	Management Engine Code is programmed at the factory. Code is updated via Intel secure firmware update utility. Unique Provisioning Data can be entered at the factory or by an administrator using the Management Engine (MEBx) setup utility. The third-party data store contents can be populated by a remote management console or local applications that have been registered by an administrator to have access to the space.	The Intel chipset is configured to enforce hardware protection to block all direct read-write access to this area. An Intel utility must be used for updating the firmware. Only firmware updates digitally signed by Intel can be applied using this utility.
Bluetooth flash (select products only)	2 megabits	No	Yes	Stores Bluetooth configuration and firmware.	Bluetooth flash is programmed at the factory. Tools for writing data to this memory are not publicly available but can be obtained from the silicon vendor.	A utility must be used for writing data to this memory and is made available through newer versions of the driver whenever the flash requires an upgrade.
802.11 WLAN EEPROM	4 kilobits to 8 kilobits	No	Yes	Stores configuration and calibration data.	802.11 WLAN EEPROM is programmed at the factory. Tools for writing data to this memory are not made public.	A utility must be used for writing data to this memory and is typically not made available to the public unless a firmware upgrade is necessary to address a unique issue.
Camera (select products only)	64 kilobits	No	Yes	Stores camera configuration and firmware.	Camera memory is programmed using a utility from the device manufacturer that can be run from Windows.	A utility must be used for writing data to this memory and is typically not made available to the public unless a firmware upgrade is necessary to address a unique issue.
Fingerprint reader (select products only)	512 KB flash	Yes	Yes	Stores fingerprint templates.	Fingerprint reader memory is programmed by user enrollment in HP ProtectTools Security Manager.	Only a digitally signed application can make the call to write to the flash.

Questions and answers

Use this section to answer your questions about nonvolatile memory.

How can the BIOS settings be restored (returned to factory settings)?

IMPORTANT: The restore defaults feature does not securely erase any information on your hard drive. See question and answer 6 for steps to securely erase information.

The restore defaults feature does not reset the Custom Secure Boot keys. See question and answer 7 for information about resetting the keys.

- **a.** Turn on or restart the computer, and then quickly press esc.
- b. Select Main, and then select Apply Factory Defaults and Exit.
- c. Follow the on-screen instructions.
- d. Select Main, select Save Changes and Exit, and then follow the on-screen instructions.

2. What is a UEFI BIOS, and how is it different from a legacy BIOS?

The Unified Extensible Firmware Interface (UEFI) BIOS is an industry-standard software interface between the platform firmware and an operating system (OS). It replaces the older BIOS architecture but supports much of the legacy BIOS functionality.

Like the legacy BIOS, the UEFI BIOS provides an interface to display the system information and configuration settings and to change the configuration of your computer before an OS is loaded. BIOS provides a secure runtime environment that supports a Graphic User Interface (GUI). In this environment, you can use either a pointing device (touch screen, touchpad, pointing stick, or USB mouse) or the keyboard to navigate and make menu and configuration selections. The UEFI BIOS also contains basic system diagnostics.

The UEFI BIOS provides functionality beyond that of the legacy BIOS. In addition, the UEFI BIOS works to initialize the computer's hardware before loading and executing the OS; the runtime environment allows the loading and execution of software programs from storage devices to provide more functionality, such as advanced hardware diagnostics (with the ability to display more detailed system information) and advanced firmware management and recovery software.

HP has provided options in Computer Setup (BIOS) to allow you to run in legacy BIOS, if required by the operating system. Examples of this requirement would be if you upgrade or downgrade the OS.

3. Where is the UEFI BIOS located?

The UEFI BIOS is located on a flash memory chip. You must use a utility to write to the chip.

4. What kind of configuration data is stored on the DIMM Serial Presence Detect (SPD) memory module? How would this data be written?

The DIMM SPD memory contains information about the memory module, such as size, serial number, data width, speed and timing, voltage, and thermal information. This information is written by the module manufacturer and stored on an EEPROM. You cannot write to this EEPROM when the memory module is installed in a computer. Third-party tools do exist that can write to the EEPROM when the memory module is not installed in a computer. Various third-party tools are available to read SPD memory.

5. What is meant by "Restore the nonvolatile memory found in Intel-based system boards"?

This message relates to clearing the Real Time Clock (RTC) CMOS memory that contains computer configuration data.

6. How can the BIOS security be reset to factory defaults and erase the data?

IMPORTANT: Resetting results in the loss of information.

These steps do not reset Custom Secure Boot Keys. See question and answer 7 for information about resetting the keys.

- **a.** Turn on or restart the computer, and then quickly press esc.
- Select Main, and then select Reset Security to Factory Defaults.
- c. Follow the on-screen instructions.
- d. Select Main, select Save Changes and Exit, and then follow the on-screen instructions.

7. How can the Custom Secure Boot Keys be reset?

Secure Boot is a feature to ensure that only authenticated code can start on a platform. If you enabled Secure Boot and created Custom Secure Boot Keys, disabling Secure Boot does not clear the keys. You must also select to clear the Custom Secure Boot Keys. Use the same Secure Boot access procedure that you used to create the Custom Secure Boot Keys, but select to clear or delete all Secure Boot Keys.

- **a.** Turn on or restart the computer, and then quickly press esc.
- Select the Security menu, select Secure Boot Configuration, and then follow the on-screen instructions.
- c. At the Secure Boot Configuration window, select Secure Boot, select Clear Secure Boot Keys, and then follow the on-screen instructions to continue.

Using HP Sure Start (select products only)

Select computer models are configured with HP Sure Start, a technology that continuously monitors your computer's BIOS for attacks or corruption.

If the BIOS becomes corrupted or is attacked, HP Sure Start restores the BIOS to its previously safe state, without user intervention. Those select computer models ship with HP Sure Start configured and enabled. HP Sure Start is configured and already enabled so that most users can use the HP Sure Start default configuration. Advanced users can customize the default configuration.

To access the latest documentation on HP Sure Start, go to http://www.hp.com/support.

10 Power cord set requirements

This chapter provides power cord requirements for countries and regions.

The wide-range input feature of the computer permits it to operate from any line voltage from 100 V ac to 120 V ac, or from 220 V ac to 240 V ac.

The three-conductor power cord set included with the computer meets the requirements for use in the country or region where the equipment is purchased.

Power cord sets for use in other countries or regions must meet the requirements of the country and region where the computer is used.

Requirements for all countries

These power cord requirements are applicable to all countries and regions.

- The length of the power cord set must be at least 1.0 m (3.3 ft) and no more than 2.0 m (6.5 ft).
- All power cord sets must be approved by an acceptable accredited agency responsible for evaluation in the country or region where the power cord set will be used.
- The power cord sets must have a minimum current capacity of 10 A and a nominal voltage rating of 125 V ac or 250 V ac, as required by the power system of each country or region.
- The appliance coupler must meet the mechanical configuration of an EN 60 320/IEC 320 Standard Sheet
 C13 connector for mating with the appliance inlet on the back of the computer.

Requirements for specific countries and regions

To determine power cord requirements for specific countries and regions, use this table.

Table 10-1 Power cord requirements for specific countries and regions

Country/region	Accredited agency	Applicable note number
Argentina	IRAM	1
Australia	SAA	1
Austria	OVE	1
Belgium	CEBEC	1
Brazil	ABNT	1
Canada	CSA	2
Chile	IMQ	1
Denmark	DEMKO	1
Finland	FIMKO	1
France	UTE	1
Germany	VDE	1

Table 10-1 Power cord requirements for specific countries and regions (continued)

Country/region	Accredited agency	Applicable note number
India	BIS	1
Israel	SII	1
Italy	IMQ	1
Japan	JIS	3
Netherlands	KEMA	1
New Zealand	SANZ	1
Norway	NEMKO	1
People's Republic of China	ССС	4
Saudi Arabia	SASO	7
Singapore	PSB	1
South Africa	SABS	1
South Korea	KTL	5
Sweden	SEMKO	1
Switzerland	SEV	1
Taiwan	BSMI	6
Thailand	TISI	1
United Kingdom	ASTA	1
United States	UL	2

- The flexible cord must be Type HO5VV-F, three-conductor, 0.75 mm² conductor size. Power cord set fittings (appliance coupler and wall plug) must bear the certification mark of the agency responsible for evaluation in the country or region where it will be used.
- The flexible cord must be Type SVT/SJT or equivalent, No. 18 AWG, three-conductor. The wall plug must be a two-pole grounding type with a NEMA 5-15P (15 A, 125 V ac) or NEMA 6-15P (15 A, 250 V ac) configuration. CSA or C-UL mark. UL file number must be on each element.
- 3. The appliance coupler, flexible cord, and wall plug must bear a T mark and registration number in accordance with the Japanese Dentori Law. The flexible cord must be Type VCTF, three-conductor, 0.75 mm² or 1.25 mm² conductor size. The wall plug must be a two-pole grounding type with a Japanese Industrial Standard C8303 (7 A, 125 V ac) configuration.
- 4. The flexible cord must be Type RVV, three-conductor, 0.75 mm² conductor size. Power cord set fittings (appliance coupler and wall plug) must bear the CCC certification mark.
- 5. The flexible cord must be Type H05VV-F three-conductor, 0.75 mm² conductor size. KTL logo and individual approval number must be on each element. Approval number and logo must be printed on a flag label.
- The flexible cord must be Type HVCTF three-conductor, 1.25 mm² conductor size. Power cord set fittings (appliance coupler, cable, and wall plug) must bear the BSMI certification mark.
- 7. For 127 V ac, the flexible cord must be Type SVT or SJT 3-conductor, 18 AWG, with plug NEMA 5-15P (15 A, 125 V ac), with UL and CSA or C-UL marks. For 240 V ac, the flexible cord must be Type H05VV-F three-conductor, 0.75 mm² or 1.00 mm² conductor size, with plug BS 1363/A with BSI or ASTA marks.

11 Recycling

When a nonrechargeable or rechargeable battery has reached the end of its useful life, do not dispose of the battery in general household waste. Follow the local laws and regulations in your area for battery disposal.

HP encourages customers to recycle used electronic hardware, HP original print cartridges, and rechargeable batteries. For more information about recycling programs, see the HP website at http://www.hp.com/recycle.

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